HP Z6 G4 Workstation

Overview

HP Z6 G4 Workstation



Front view

- 1. Integrated Front Handle
- 2. Front I/O module options
 - Premium (optional, shown here): power button, 2 USB 3.1 G1 Type-A, 2 USB 3.1 G2 Type-C[™] (Left-most Type A port has charging capability), Headset/Mic, Media Card Reader (optional).
 - Standard: power button, 4 USB 3.1 G1 Type-A (left-most Type A port has charging capability), Headset/Mic, Media Card Reader (optional).
- 3. 2 x 5.25" external bays
- 4. 1 Slim ODD bay



HP Z6 G4 Workstation

QuickSpecs

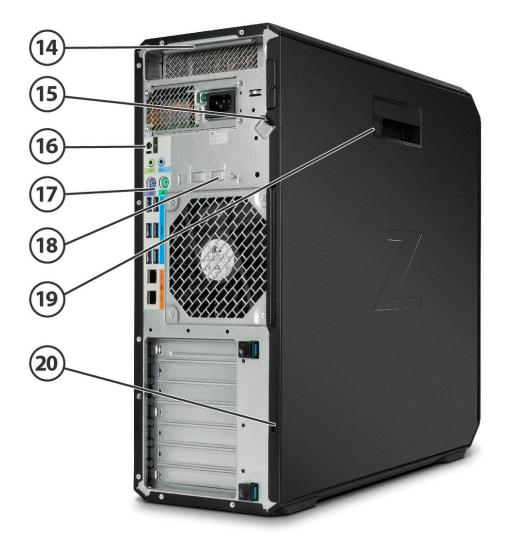
Overview



Internal view

- 5. Power supply: 1000W 90% efficient with 2 graphics power adapters
- 6. 6 DIMM slots: DDR4-2666 Registered RAM
- 7. Intel[®] Xeon[®] processor Scalable family
- 8. 2nd CPU & memory riser connector: adds 2nd CPU socket and (6) DIMM slots
- 9. PCIe slots: 2 PCIe G3 x16, 3 PCIe G3 x4, 1 PCIe G3 x8
- 10. 6 x 6Gb/s SATA ports
- 11. 2 PCIe G3 x4 M.2 for SSDs
- 12. 2 x 2.5"/3.5" internal drive bays
- 13. 2 x 5.25" external drive bays

Overview



Rear view

- 14. Rear handle
- 15. Padlock loop
- 16. Rear power button
- Rear I/O (top to bottom): audio in/out, keyboard/mouse PS/2, 6 USB 3.1 G1 Type-A, 2 x 1GbE LAN ports

- 18. HP Dual Port 10GBase-T NIC module slot (optional)
- 19. Side panel barrel keylock (optional)
- 20. Kensington lock slot

Overview

Form Factor Operating Systems Tower Preinstalled:

- Windows 10 Pro 64 for Workstations¹
- HP Linux-ready (minimal OS ready for customer OS installation)
- Red Hat[®] Enterprise Linux[®] Desktop Workstation (Paper license with 1 year support; no preinstalled OS)

Supported:

- Red Hat Enterprise Linux Desktop 7.4²
- SUSE Linux Enterprise Desktop 12 SP3²
- Ubuntu 16.04 LTS²

¹Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

²**Notes**: For detailed Linux[®] OS/hardware support information, see: http://www.hp.com/support/linux_hardware_matrix

Note: In accordance with Microsoft's support policy, HP does not support the Windows[®] 7 operating system on products configured with Intel[®] 7th Generation and forward processors.

Available Processors

| Name | Cores | Clock Speed (GHz) | Cache (MB) | Memory Speed (MT/s) | Hyper- Threading | Intel® Turbo Boost Technology ¹ | Supports Intel® DCPMM Technology ² | TDP (W) |
|---|-------|-------------------------|---------------|---------------------------|---------------------|--|--|------------|
| | | | Intel® Xeo | n® W Processo | ors | | | |
| Intel® Xeon® W-3245 processor | 16 | 3.2 GHz | 22 | 2933 | YES | 4.4, 4.6 | NO | 205 |
| Intel® Xeon® W-3235 processor | 12 | 3.3 GHz | 19.25 | 2933 | YES | 4.4, 4.5 | NO | 180 |
| Intel® Xeon® W-3225 processor | 8 | 3.7 GHz | 16.5 | 2666 | YES | 4.3, 4.4 | NO | 160 |
| Intel® Xeon® W-3223 processor | 8 | 3.5 GHz | 16.5 | 2666 | YES | 4, 4.2 | NO | 160 |
| | | l | ntel® Xeon® S | calable Proce | essors | | | |
| Intel® Xeon® Platinum 8280 processor | 28 | 2.7 GHz | 38.50 | 2933 | YES | 3.3, 4.0 | YES | 205 |
| Intel® Xeon® Platinum 8260 processor | 24 | 2.4 GHz | 35.75 | 2933 | YES | 3.1, 3.9 | YES | 165 |
| Intel® Xeon® Platinum 8180 processor | 28 | 2.5 GHz | 38.50 | 2666 | YES | 3.2, 3.8 | NO | 205 |
| Intel® Xeon® Platinum 8160 processor | 24 | 2.1 GHz | 33.00 | 2666 | YES | 2.8, 3.7 | NO | 150 |
| Intel® Xeon® Gold 6258R processor | 28 | 2.7 GHz | 38.50 | 2933 | YES | 4.0, 3.4 | YES | 205 |
| Intel® Xeon® Gold 6254 processor | 18 | 3.1 GHz | 24.75 | 2933 | YES | 3.9, 4.0 | YES | 200 |
| Intel® Xeon® Gold 6252 processor | 24 | 2.1 GHz | 35.75 | 2933 | YES | 2.8, 3.7 | YES | 150 |



| Intel® Xeon® Gold 6248R processor | 24 | 3.0 GHz | 35.75 | 2933 | YES | 4.0, 3.9 | YES | 205 |
|--------------------------------------|----|---------|-------|------|-----|----------|-----|-----|
| Intel® Xeon® Gold 6248 processor | 20 | 2.5 GHz | 27.50 | 2933 | YES | 3.2, 3.9 | YES | 150 |
| Intel® Xeon® Gold 6246R processor | 16 | 3.4 GHz | 35.75 | 2933 | YES | 4.1, 4.0 | YES | 205 |
| Intel® Xeon® Gold 6244 processor | 8 | 3.6 GHz | 24.75 | 2933 | YES | 4.3, 4.4 | YES | 150 |
| Intel® Xeon® Gold 6242R processor | 20 | 3.1 GHz | 35.75 | 2933 | YES | 4.1, 3.8 | YES | 205 |
| Intel® Xeon® Gold 6242 processor | 16 | 2.6 GHz | 22 | 2933 | YES | 3.5, 3.9 | YES | 150 |
| Intel® Xeon® Gold 6240R processor | 24 | 2.4 GHz | 35.75 | 2933 | YES | 4.0, 3.2 | YES | 165 |
| Intel® Xeon® Gold 6240Y processor | 18 | 2.6 GHz | 24.75 | 2933 | YES | 3.3, 3.9 | YES | 150 |
| Intel® Xeon® Gold 6240 processor | 18 | 2.6 GHz | 24.75 | 2933 | YES | 3.3, 3.9 | YES | 150 |
| Intel® Xeon® Gold 6238R processor | 28 | 2.2 GHz | 38.5 | 2933 | YES | 4.0, 3.0 | YES | 165 |
| Intel® Xeon® Gold 6230R processor | 26 | 2.1 GHz | 35.75 | 2933 | YES | 4.0, 3.0 | YES | 150 |
| Intel® Xeon® Gold 6230 processor | 20 | 2.1 GHz | 27.50 | 2933 | YES | 2.8, 3.9 | YES | 125 |
| Intel® Xeon® Gold 6226 processor | 12 | 2.7 GHz | 19.25 | 2933 | YES | 3.5, 3.7 | YES | 125 |
| Intel® Xeon® Gold 6152 processor | 22 | 2.1 GHz | 30.25 | 2666 | YES | 2.8, 3.7 | NO | 140 |
| Intel® Xeon® Gold 6154 processor | 18 | 3.0 GHz | 24.75 | 2666 | YES | 3.7, 3.7 | NO | 200 |
| Intel® Xeon® Gold 6148 processor | 20 | 2.4 GHz | 27.50 | 2666 | YES | 3.1, 3.7 | NO | 150 |
| Intel® Xeon® Gold 6146 processor | 12 | 3.2 GHz | 24.75 | 2666 | YES | 3.9, 4.2 | NO | 165 |
| Intel® Xeon® Gold 6144 processor | 8 | 3.5 GHz | 24.75 | 2666 | YES | 4.1, 4.2 | NO | 150 |
| Intel® Xeon® Gold 6142 processor | 16 | 2.6 GHz | 22.00 | 2666 | YES | 3.3, 3.7 | NO | 150 |
| Intel® Xeon® Gold 6140 processor | 18 | 2.3 GHz | 24.75 | 2666 | YES | 3.0, 3.7 | NO | 140 |
| Intel® Xeon® Gold 6138 processor | 20 | 2.0 GHz | 27.5 | 2666 | YES | 2.7, 3.7 | NO | 125 |
| Intel® Xeon® Gold 6136 processor | 12 | 3.0 GHz | 24.75 | 2666 | YES | 3.6, 3.7 | NO | 150 |
| Intel® Xeon® Gold 6134 processor | 8 | 3.2 GHz | 24.75 | 2666 | YES | 3.7, 3.7 | NO | 130 |
| Intel® Xeon® Gold 6132 processor | 14 | 2.6 GHz | 19.25 | 2666 | YES | 3.3, 3.7 | NO | 140 |
| Intel® Xeon® Gold 6130 processor | 16 | 2.1 GHz | 22.00 | 2666 | YES | 2.8, 3.7 | NO | 125 |
| Intel® Xeon® Gold 6128 processor | 6 | 3.4 GHz | 19.25 | 2666 | YES | 3.7, 3.7 | NO | 115 |
| Intel® Xeon® Gold 5222 processor | 4 | 3.8 GHz | 16.5 | 2666 | YES | 3.9, 3.9 | YES | 105 |
| Intel® Xeon® Gold 5220R processor | 24 | 2.2 GHz | 35.75 | 2666 | YES | 4.0, 2.9 | YES | 150 |
| | | | | | | | | |



| Intel [®] Xeon [®] Gold 5220 | 18 | 2.2 GHz | 24.75 | 2666 | YES | 2.7, 3.9 | YES | 105 |
|---|----|---------|-------|------|-----|----------|-----|-----|
| processor Intel® Xeon® Gold 5218R processor | 20 | 2.1GHz | 27.5 | 2666 | YES | 4.0, 2.9 | YES | 125 |
| Intel® Xeon® Gold 5218 processor | 16 | 2.3 GHz | 22 | 2666 | YES | 2.8, 3.9 | YES | 125 |
| Intel® Xeon® Gold 5215 processor | 10 | 2.5 GHz | 13.75 | 2666 | YES | 3.0, 3.4 | YES | 85 |
| Intel® Xeon® Gold 5120 processor | 14 | 2.2 GHz | 19.25 | 2400 | YES | 2.6, 3.2 | NO | 105 |
| Intel® Xeon® Gold 5118 processor | 12 | 2.3 GHz | 16.50 | 2400 | YES | 2.7, 3.2 | NO | 105 |
| Intel® Xeon® Gold 5115 processor | 10 | 2.4 GHz | 13.75 | 2400 | YES | 2.8, 3.2 | NO | 85 |
| Intel® Xeon® Gold 5122 processor | 4 | 3.6 GHz | 16.50 | 2666 | YES | 3.7, 3.7 | NO | 105 |
| Intel® Xeon® Silver 4216 processor | 16 | 2.1 GHz | 22 | 2400 | YES | 2.7, 3.2 | NO | 100 |
| Intel® Xeon® Silver 4215R processor | 8 | 3.2 GHz | 11 | 2400 | YES | 4.0, 3.6 | YES | 130 |
| Intel® Xeon® Silver 4215 processor | 8 | 2.5 GHz | 11 | 2400 | YES | 3.0, 3.5 | YES | 85 |
| Intel® Xeon® Silver 4214R processor | 12 | 2.4 GHz | 16.5 | 2400 | YES | 3.0, 3.5 | NO | 100 |
| Intel® Xeon® Silver 4214Y processor | 12 | 2.2 GHz | 16.5 | 2400 | YES | 2.7, 3.2 | NO | 85 |
| Intel® Xeon® Silver 4214 processor | 12 | 2.2 GHz | 16.5 | 2400 | YES | 2.7, 3.2 | NO | 85 |
| Intel® Xeon® Silver 4210R processor | 10 | 2.4 GHz | 13.75 | 2400 | YES | 2.9, 3.2 | NO | 100 |
| Intel® Xeon® Silver 4210 processor | 10 | 2.2 GHz | 13.75 | 2400 | YES | 2.7, 3.2 | NO | 85 |
| Intel® Xeon® Silver 4208 processor | 8 | 2.1 GHz | 11 | 2400 | YES | 2.5, 3.2 | NO | 85 |
| Intel® Xeon® Silver 4116 processor | 12 | 2.1 GHz | 16.50 | 2400 | YES | 2.4, 3.0 | NO | 85 |
| Intel® Xeon® Silver 4114 processor | 10 | 2.2 GHz | 13.75 | 2400 | YES | 2.5, 3.0 | NO | 85 |
| Intel® Xeon® Silver 4112 processor | 4 | 2.6 GHz | 8.25 | 2400 | YES | 2.9, 3.0 | NO | 85 |
| Intel® Xeon® Silver 4110 processor | 8 | 2.1 GHz | 11.00 | 2400 | YES | 2.4, 3.0 | NO | 85 |
| Intel® Xeon® Silver 4108 processor | 8 | 1.8 GHz | 11.00 | 2400 | YES | 2.1, 3.0 | NO | 85 |
| Intel® Xeon® Silver 3206R processor | 8 | 1.9 GHz | 11.00 | 2133 | YES | N/A | NO | 85 |
| Intel® Xeon® Bronze 3204 processor | 6 | 1.9 GHz | 8.25 | 2133 | YES | N/A | NO | 85 |
| Intel® Xeon® Bronze 3106 processor | 8 | 1.7 GHz | 11.00 | 2133 | NO | N/A | NO | 85 |
| Intel® Xeon® Bronze 3104 processor | 6 | 1.7 GHz | 8.25 | 2133 | NO | N/A | NO | 85 |



| | All Z6G4 Intel® Xeon® CPUs Feature Intel® vPro™ Technology. |
|---|--|
| | ¹ The specifications shown in this column represent the following: (all core maximum turbo frequency, one core maximum turbo frequency). Processors that do not have turbo functionality are denoted as N/A. |
| | ² Intel [®] Data Center Persistent Memory Modules availability will be announced at a future date. |
| Available Processors | |
| Disclaimers | When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. |
| | Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance. |
| Color | Black |
| Convertibility | Νο |
| Expansion Slots (see system board section for more details) | Slot 0: Mechanical-only, for use with devices that require only rear bulkhead mounting or when 2 nd CPU riser is installed |
| | Slot 1: PCI Express Gen3 x4 - CPU with open-ended connector* |
| | Slot 2: PCI Express Gen3 x16 - CPU |
| | Slot 3: PCI Express Gen3 x4 - PCH with open-ended connector* |
| | Slot 4: PCI Express Gen3 x8 – CPU with open-ended connector (slot converts to x4 electrical when SSD is installed in 2nd M.2 slot)* |
| | Slot 5: PCI Express Gen3 x16 - CPU |
| | Slot 6: PCI Express Gen3 x4 - PCH with open-ended connector* |
| | M.2 Slot 1: M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices |
| | M.2 Slot 2: M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices |
| | * Open-ended connector allows a greater bandwidth (e.g. x16) card to be installed physically into a lower bandwidth connector/slot. |
| | M.2 Slot 1: M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices M.2 Slot 2: M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices * Open-ended connector allows a greater bandwidth (e.g. x16) card to be installed physically into a storage devices |



| Expansion Bays (see storage section for more details) | 2 internal 3.5" bays (with acoustic dampening rail assemblies pre-installed) 2 external 5.25" bays 3rd and 4th 3.5" HDD each occupy one external bay 3rd and 4th 2.5" HDD/SSD occupy a single external bay within a 2:1 carrier) |
|---|---|
| | 1 dedicated 9.5mm slim optical disk drive bay |
| Front I/O | Base: Power button, 1 Headset audio port, 4 USB 3.1 G1 Type A (1 charging) Premium (optional): Power button, 1 Headset audio port, 2 USB 3.1 G2 Type C[™], 2 USB 3.1 G1 Type A (1 charging) Optional: SD reader |
| Internal I/O | 1 USB 3.1 G1 (aka USB 3.0) single-port header, 1 USB 2.0 single-port header and 1 USB 2.0 dual-port header |
| Rear I/O | 6 USB 3.1 G1 (aka USB 3.0) Type A ports, 2 1Gbe LAN ports (1x supporting Intel® AMT), Audio: 1 Line out, 1 Line in (Line in can be retasked as microphone), 1 PS/2 mouse port, 1 PS/2 keyboard port, 1 Rear power button Optional: 1 serial port (cable up to rear bulkhead) |
| Interfaces Supported | SD card reader (optional) 6-channel SATA interface (6 @ 6.0 Gb/s) 6 channels are eSATA configurable for use with eSATA CTO/AMO Kit (No hot plug / hot swap supported) USB 2.0, USB 3.1 G1 (aka USB 3.0), USB 3.1 G2 (optional) |
| On-board RAID Support | SATA RAID 0 Striped Array SATA RAID 1 Mirrored Array SATA RAID 5 Striped/Parity SATA RAID 10 Striped/Mirrored |
| Chassis Dimensions (H x W x D) | H: 17.5" (445mm) W: 6.65" (169mm) D: 18.3" (465mm) |
| Packaged Dimensions | H: 24" (610mm) W: 12.3" (313mm) D: 23.3" (593mm) |
| Rack Dimensions | 4U |
| Weight | Exact weights depend upon configuration (System weight only). Minimum: 13.1 kg (29 lbs.) Standard: 13.6 kg (30.1 lbs.) Maximum: 23.9 kg (52.7 lbs.) |
| Temperature | Operating: 5° to 35°C (40° to 95°F) Non-operating: -40° to 60°C (-40° to 140°F) |
| | Note: Above 1524 m (5,000 feet) altitude, maximum operating temperature is reduced by 1° C (1.8° F) per 305 m (1,000 feet) elevation increase |
| Humidity | Operating: 10% to 85% relative humidity, non-condensing, 35° C maximum wet bulb Non-operating: 10% to 90% relative humidity, non-condensing, 35° C maximum wet bulb |
| Maximum Altitude (non- pressurized) | Operating: 3,048m (10,000ft) Non-operating: 9,144m (30,000ft) |



| Overview | | | | | |
|-----------------------------------|---|--|--|--|--|
| | Note: Above 1524 m (5,000 feet) altitude, maximum operating temperature is reduced by 1° C (1.8° F) per 305 m (1,000 feet) elevation increase | | | | |
| Power Supply | 1000 watts wide-ranging, active Power Factor Correction, 90% Efficient, with 2X 6-pin graphics power cables (graphics power cables are 6/8-pin convertible) | | | | |
| | The Z6 G4 1000W power supply efficiency report can be found at this link: https://plugloadsolutions.com/psu_reports/HP_D15-1K0P1A_1000W_ECOS%204838_Report.pdf | | | | |
| Workstation ISV Certifications | See the latest list of certifications at http://www8.hp.com/us/en/campaigns/workstations/industries-and-partners.html | | | | |

Supported Components

Processors

| | Factory Configured | Option Kit | Option Kit Part Number ¹ | Support Notes |
|--|-----------------------|---------------|---|------------------|
| Intel® Xeon® W-3200 Series CPU | | | | |
| Intel® Xeon® W-3245 3.2 2933 16C processor | Y | Ν | | |
| Intel® Xeon® W-3235 3.3 2933 12C processor | Y | Ν | | |
| Intel® Xeon® W-3225 3.7 2666 8C processor | Y | Ν | | |
| Intel® Xeon® W-3223 3.5 2666 8C processor | Y | Ν | | |
| Intel® Xeon® Scalable CPU | | | | |
| Intel® Xeon® Platinum 8280 processor | Y | Ν | | 1 |
| Intel® Xeon® Platinum 8260 processor | Y | Ν | | 1 |
| Intel [®] Xeon [®] Platinum 8180 processor | Y | Ν | | |
| Intel [®] Xeon [®] Platinum 8160 processor | Y | Y | 1XM35AA | |
| Intel [®] Xeon [®] Gold 6258R processor | Y | Ν | | |
| Intel [®] Xeon [®] Gold 6254 processor | Y | Ν | | 1 |
| Intel [®] Xeon [®] Gold 6252 processor | Y | Y | 5YT07AA | 1 |
| Intel [®] Xeon [®] Gold 6248R processor | Y | Ν | | |
| Intel [®] Xeon [®] Gold 6248 processor | Y | Y | 5YT06AA | 1 |
| Intel [®] Xeon [®] Gold 6246R processor | Y | Ν | | |
| Intel [®] Xeon [®] Gold 6244 processor | Y | Y | 5YT05AA | 1 |
| Intel [®] Xeon [®] Gold 6242R processor | Y | Ν | | 1 |
| Intel [®] Xeon [®] Gold 6242 processor | Y | Y | 5YT04AA | 1 |
| Intel [®] Xeon [®] Gold 6240R processor | Y | Ν | | 1 |
| Intel [®] Xeon [®] Gold 6240Y processor | Y | | 5YT03AA | 1 |
| Intel [®] Xeon [®] Gold 6240 processor | Y | Y | 5YT02AA | 1 |
| Intel [®] Xeon [®] Gold 6238R processor | Y | Ν | | 1 |
| Intel [®] Xeon [®] Gold 6230R processor | Y | Y | 9VA87AA | 1 |
| Intel [®] Xeon [®] Gold 6230 processor | Y | Y | 5YS99AA | 1 |
| Intel [®] Xeon [®] Gold 6226R processor | Y | Y | 9VA85AA | 1 |
| Intel [®] Xeon [®] Gold 6226 processor | Y | Y | 5YS98AA | 1 |
| Intel [®] Xeon [®] Gold 6152 processor | Y | Y | 1XM36AA | |
| Intel [®] Xeon [®] Gold 6154 processor | Y | Ν | | |
| Intel [®] Xeon [®] Gold 6148 processor | Y | Y | 1XM37AA | |
| Intel [®] Xeon [®] Gold 6146 processor | Y | Ν | | |
| Intel [®] Xeon [®] Gold 6144 processor | Y | Y | 3BA12AA | |
| Intel [®] Xeon [®] Gold 6142 processor | Y | Y | 1XM38AA | |
| Intel [®] Xeon [®] Gold 6140 processor | Y | Y | 1XM40AA | |
| Intel [®] Xeon [®] Gold 6138 processor | Y | Y | 3GG95AA | |
| Intel [®] Xeon [®] Gold 6136 processor | Y | Y | 1XM39AA | |
| Intel® Xeon® Gold 6134 processor | Y | Y | 1XM41AA | |
| Intel [®] Xeon [®] Gold 6132 processor | Y | Y | 1XM42AA | |
| Intel® Xeon® Gold 6130 processor | Y | Y | 1XM43AA | |
| Intel [®] Xeon [®] Gold 6128 processor | Y | Y | 1XM44AA | |
| - | V | V | | |
| Intel [®] Xeon [®] Gold 5222 processor | Y | Y | 5YS97AA | 1 |



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HP Z6 G4 Workstation

QuickSpecs

Supported Components

| Intel [®] Xeon [®] Gold 5220 processor | Y | Y | 5YS96AA | 1 |
|---|---|---|---------|---|
| Intel [®] Xeon [®] Gold 5218R processor | Y | Y | 9VA83AA | 1 |
| Intel® Xeon® Gold 5218 processor | Y | Y | 5YS95AA | 1 |
| Intel [®] Xeon [®] Gold 5215 processor | Y | Y | 5YS94AA | 1 |
| Intel [®] Xeon [®] Gold 5120 processor | Y | Y | 1XM47AA | |
| Intel [®] Xeon [®] Gold 5118 processor | Y | Y | 1XM45AA | |
| Intel [®] Xeon [®] Gold 5115 processor | Y | Y | 1XM46AA | |
| Intel [®] Xeon [®] Gold 5122 processor | Y | Y | 4MB89AA | |
| Intel [®] Xeon [®] Gold 4216 processor | Y | Y | 5YS93AA | |
| Intel [®] Xeon [®] Gold 4215 processor | Y | Y | 5YS92AA | 1 |
| Intel [®] Xeon [®] Gold 4214R processor | Y | Y | 8BC96AA | 1 |
| Intel [®] Xeon [®] Gold 4214Y processor | Y | Y | 5ZB33AA | |
| Intel [®] Xeon [®] Gold 4214 processor | Y | Y | 5YS91AA | |
| Intel [®] Xeon [®] Gold 4210R processor | Y | Y | 8BD02AA | |
| Intel [®] Xeon [®] Gold 4210 processor | Y | Y | 5YS90AA | |
| Intel [®] Xeon [®] Gold 4208 processor | Y | Y | 5YS89AA | |
| Intel [®] Xeon [®] Silver 4116 processor | Y | Y | 1XM48AA | |
| Intel [®] Xeon [®] Silver 4114 processor | Y | Y | 1XM49AA | |
| Intel [®] Xeon [®] Silver 4112 processor | Y | Y | 1XM50AA | |
| Intel [®] Xeon [®] Silver 4110 processor | Y | Y | 3GG94AA | |
| Intel [®] Xeon [®] Silver 4108 processor | Y | Y | 1XM51AA | |
| Intel [®] Xeon [®] Bronze 3206R processor | Y | Y | 8BC93AA | |
| Intel [®] Xeon [®] Gold 3204 processor | Y | Y | 5YS88AA | |
| Intel [®] Xeon [®] Bronze 3106 processor | Y | Y | 1XM52AA | |
| Intel [®] Xeon [®] Bronze 3104 processor | Y | Y | 1XM53AA | |
| | | | | |

¹ Options kits available for second processor upgrade.

Disclaimers: When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families.

Note 1: Intel® DCPMM® (Data Center Persistent Memory) Supported.

| Monitors / Displays | | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|------------------------|--------------------------------|-----------------------|---------------|------------------------------|------------------|
| | HP Z Display Z22n G2 | | Y | 1JS05AA | |
| | HP Z Display Z23n G2 | | Y | 1JS06AA | |
| | HP Z Display Z24i G2 | | Y | 1JS08AA | |
| | HP Z Display Z24n G2 | | Y | 1JS09AA | |
| | HP Z Display Z24nf G2 | | Y | 1JS07AA | |
| | HP Z Display Z27n G2 | | Y | 1JS10AA | |
| | HP Z Display Z27s (4K display) | | Y | J3G07AA | |



Supported Components

Supported by all operating systems available from HP Screen size measured diagonally

Storage / Hard Drives

| SAS Hard Drives | SAS Hard Drives for HP Workstations | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|-----------------|---|-----------------------|---------------|------------------------------|------------------|
| | HP 300GB 15k SAS SFF NOTE: SAS controller add-in card required | Y | Y | L5B74AA | |

| SATA Hard Drives | | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|------------------|---|-----------------------|------------|------------------------------|------------------|
| | SATA (Serial ATA) Hard Drives for HP Workstations | | | | |
| | 500GB SATA 7200RPM 6Gb/s 3.5" HDD | Y | Y | LQ036AA | |
| | 500GB SATA 7200RPM 6Gb/s OPAL2 SFF 3.5" HDD | Y | Y | D8N29AA | |
| | 1TB SATA 7200RPM 3.5" HDD | Y | Y | LQ037AA | |
| | 1TB SATA 7200RPM Ent 3.5" HDD | Y | Y | WOR10AA | |
| | 2TB SATA 7200RPM HDD | Y | Y | QB576AA | |
| | 2TB SATA 7200RPM HDD SMR | | | | |
| | 4TB SATA 7200RPM Ent 3.5" HDD | Y | Y | K4T76AA | |
| | 6TB SATA 7200RPM Ent 3.5" HDD | Y | Y | 3DH90AA | |
| | NOTES: | | | | |

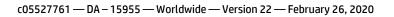
Up to (4) 3.5-inch 7200 rpm SATA drives: 500 GB, 1.0, 2.0, 4.0 TB; maximum system HDD storage: 16.0TB



Supported Components

| SATA Solid State Drives | | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|-------------------------|---|-----------------------|---------------|------------------------------|------------------|
| | HP Solid State Drives (SSDs) for Workstations | | | | |
| | HP 256GB SATA SSD | Y | Y | A3D26AA | |
| | HP 512GB SATA SSD | Y | Y | D8F30AA | |
| | HP 1TB SATA SSD | Y | Y | F3C96AA | |
| | HP 2TB SATA SSD | Y | Y | Y6P08AA/AT | |
| | HP 256GB SATA SED OPAL2 SSD | Y | Y | G7U67AA | |
| | HP 512GB SATA SED OPAL2 SSD | Y | Y | N8T26AA | |
| | HP 240GB SATA Enterprise SSD | Y | Y | T3U07AA | |
| | HP 480GB SATA Enterprise SSD | Y | Y | T3U08AA | |

| PCIe Solid State Drives | | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|-------------------------|--|-----------------------|---------------|------------------------------|------------------|
| | PCIe SSDs for HP Workstations | | | | |
| | HP Z Turbo Drive 256GB MLC Z4/Z6 G4 SSD Kit | Y | Y | 1PD56AA | 4 |
| | HP Z Turbo Drive 512GB MLC Z4/Z6 G4 SSD Kit | Y | Ŷ | 1PD57AA/AT | 4 |
| | HP Z Turbo Drive 1TB MLC Z4/Z6 G4 SSD Kit | Y | Y | 1PD58AA | 4 |
| | HP Z Turbo Drive 256GB TLC Z4/Z6 G4 SSD Kit | Y | Y | 1PD59AA/AT | |
| | HP Z Turbo Drive 512GB TLC Z4/Z6 G4 SSD Kit | Y | Y | 1PD60AA | |
| | HP Z Turbo Drive 1TB TLC Z4/Z6 G4 SSD Kit | Y | Y | 1PD61AA | |
| | HP Z Turbo Drive 2TB TLC Z4/Z6 G4 SSD Kit | Y | Y | ЗКРЗ9АА | |
| | HP Z Turbo Drive 256GB Z4/Z6 G4 SED Kit | Ν | Ν | EOL | 4 |
| | HP Z Turbo Drive 512GB Z4/Z6 G4 SED Kit | Ν | Ν | EOL | 4 |
| | HP Z Turbo Drive 1TB TLC Z4/Z6 G4 SED Kit | Y | Y | 6YT76AA | |
| | HP Z Turbo Drive 1TB TLC Z4/Z6 G4 SED Module | Y | Y | 6YT79AA | |
| | HP 256GB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit | Y | Y | 8PE68AA | 3 |
| | HP 512GB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit | Y | Y | 8PE69AA | 3 |
| | HP 1TB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit | Y | Y | 8PE70AA | 3 |
| | HP 256GB M.2 2280 PCIe NVMe TLC SSD Module | Ν | Y | 8PE62AA | 2 |
| | HP 512GB M.2 2280 PCIe NVMe TLC SSD Module | Ν | Y | 8PE63AA | 2 |
| | HP 1TB M.2 2280 PCIe NVMe TLC SSD Z2 Module | Ν | Y | 8PE64AA | 2 |
| | HP Z Turbo Drive Dual Pro | | | | |
| | HP Z Turbo Drive Dual Pro 256GB TLC SSD | Y | Y | 4YF60AA | 3 |
| | HP Z Turbo Drive Dual Pro 512GB TLC SSD | Y | Y | 4YF61AA | 3 |
| | HP Z Turbo Drive Dual Pro 1TB TLC SSD | Y | Y | 4YF62AA | 3 |
| | HP Z Turbo Drive Dual Pro 2TB TLC SSD | Y | Y | 4YF63AA | 3 |
| | HP 256GB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit | Y | Y | 8PE74AA | 3 |
| | HP 512GB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit | Υ | Y | 8PE75AA | 3 |





Supported Components

| HP 1TB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit | Y | Y | 8PE76AA | 3 |
|--|---|---|---------|---|
| HP Z Turbo Drive Quad Pro | | | | |
| HP Z Turbo Drive Quad Pro 2x256GB PCIe TLC SSD | Y | Y | 4YZ38AA | 1 |
| HP Z Turbo Drive Quad Pro 2x512GB PCIe TLC SSD | Y | Y | 4YZ39AA | 1 |
| HP Z Turbo Drive Quad Pro 2x1TB PCIe TLC SSD | Y | Y | 4YZ40AA | 1 |
| HP Z Turbo Drive Quad Pro 2x2TB PCIe TLC SSD | Y | Y | 3KP42AA | |
| HP Z Turbo Drive Quad Pro 256GB SSD module | Ν | Y | N2N00AA | 2 |
| HP Z Turbo Drive Quad Pro 512GB SSD module | Ν | Y | N2N01AA | 2 |
| HP Z Turbo Drive Quad Pro 1TB SSD module | Ν | Y | T9J00AA | 2 |
| HP Z Turbo Drive Quad Pro 2TB SSD module | Ν | Y | 3KP43AA | |
| Intel® 905p Series SSD (Opatane SSD) | | | | |
| Intel® Optane SSD 905p 280GB AiC** | Y | Y | 2SC47AA | |
| Intel® Optane SSD 905p 480GB AiC** | Y | Y | 2SC48AA | |
| Intel® Optane SSD 905p 380GB M.2 SSD Module | Y | Y | 6LA66AA | |
| | | | | |

Note 1: Dual M.2 SSD modules plus carrier and heat sink Note 2: M.2 SSD module only, for Quad Pro or Dual Pro carrier Note 3: Single M.2 SSD module plus dual carrier and heat sink Note 4: These M.2 SSD kits and module are End of Life and no longer available. ** PCIe card installed in standard PCIe x4 slot

| Hard Drive Controllers | | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|------------------------|--|-----------------------|---------------|------------------------------|------------------|
| | SAS Controller | | | | |
| | MicroSemi SmartHBA2100-4i4e SAS Controller | Y | Y | 1FV90AA | |

Graphics

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes | Supported # of cards |
|---|-----------------------|---------------|---------------------------|------------------|-------------------------|
| Graphics Cable Adapters | _ | | | | |
| HP DisplayPort to VGA Adapter | Y | Y | AS615AA | | |
| HP DisplayPort to HDMI Adapter | Y | Y | K2K92AA | | |
| HP DisplayPort to Dual Link DVI Adapter | Y | Y | NR078AA | | 1 |
| HP DisplayPort to DVI-D Adapter | Y | Y | FH973AA | | 1 |
| HP DisplayPort to DVI-D Adapter (2-pack) | Y | Ν | | | 1 |
| HP DisplayPort to DVI-D Adapter (4-pack) | Y | Ν | | | 1 |
| HP DisplayPort to DVI-D Adapter (6-pack) | Y | Ν | | | 1 |
| NVIDIA [®] SLI 3-slot Graphics Connector | Y | Y | 2YY85AA | | 1 |
| Entry 3D | | | | | |
| NVIDIA [®] Quadro [®] P400 2GB Graphics | Y | Y | 1ME43AA | | 2 |
| NVIDIA [®] Quadro [®] P620 2GB Graphics | Y | Y | 3ME25AA | | 2 |
| AMD FirePro™ W2100 2GB Graphics | Y | Y | J3G91AA | | 2 |



Supported Components

| Mid-range 3D | | | | |
|---|---|---|---------|---|
| NVIDIA [®] Quadro [®] P1000 4GB Graphics | Y | Y | 1ME01AA | 3 |
| NVIDIA [®] Quadro [®] P2000 5GB Graphics | Y | Y | 1ME41AA | 2 |
| NVIDIA [®] Quadro [®] P2200 5GB Graphics | Y | Y | 6YT67AA | 2 |
| AMD Radeon™ Pro WX 3100 4GB Graphics | Y | Y | 2TF08AA | 2 |
| AMD Radeon™ Pro WX 3200 4GB Graphics | Y | Y | 6YT68AA | 2 |
| AMD Radeon™ Pro WX 4100 4GB Graphics | Y | Y | ZOB15AA | 2 |
| High End 3D | | | | |
| NVIDIA [®] Quadro [®] P4000 8GB Graphics | Y | Y | 1ME40AA | 2 |
| NVIDIA [®] Quadro RTX 4000 8GB Graphics | Y | Y | 5JV89AA | 2 |
| AMD Radeon™ Pro WX 7100 8GB Graphics | Y | Y | ZOB14AA | 2 |
| Ultra High-End 3D | | | | |
| NVIDIA [®] Quadro [®] GP100 16GB Graphics | Y | | 1ZE81AA | 1 |
| NVIDIA [®] Quadro [®] P5000 16GB Graphics | Y | Y | ZOB13AA | 2 |
| NVIDIA [®] Quadro [®] P6000 24GB Graphics | Y | Y | ZOB12AA | 1 |
| NVIDIA [®] Quadro RTX 5000 16GB Graphics | Y | Y | 5JH81AA | 1 |
| NVIDIA [®] Quadro RTX 6000 24GB Graphics | Y | Y | 5JH80AA | 1 |
| NVIDIA [®] Quadro RTX 8000 48GB Graphics | Y | Y | 6NB51AA | 1 |
| AMD Radeon™ Pro WX 9100 16GB Graphics | Y | Y | 2TF01AA | 1 |
| NVIDIA [®] Quadro [®] Sync II | Y | Y | 1WT20AA | |
| | | | | |

| Memory | СТО | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--------|--|-----------------------|---------------|---------------------------|------------------|
| | DDR4-2666 ECC Registered DIMMs | | | | |
| | 8GB (1x8GB) DDR4-2666 ECC Reg Memory | Y | Y | 1XD84AA | 1 |
| | 16GB (1x16GB) DDR4-2666 ECC Reg Memory | Ν | Y | 1XD85AA | 1 |
| | 32GB (1x32GB) DDR4-2666 ECC Reg Memory | Ν | Y | 1XD86AA | 1 |
| | DDR4-2933 ECC Registered DIMMs | | | | |
| | 8GB (1x8GB) DDR4-2933 ECC Reg Memory | Y | Y | 5YZ56AA | 1 |
| | 16GB (1x16GB) DDR4-2933 ECC Reg Memory | Ν | Y | 5YZ54AA | 1 |
| | 32GB (1x32GB) DDR4-2933 ECC Reg Memory | Ν | Y | 5YZ55AA | 1 |
| | 64GB (1x64GB) DDR4-2399 ECC Reg Memory | Ν | Y | 5YZ57AA | 1 |

NOTE 1: For details on the supported memory configurations on the HP Z6 G4 Workstation, please refer to the System Technical Specifications - System Board section of this document.

Each processor supports up to 6 channels of DDR4 memory. To realize full performance at least 1 DIMM must be inserted into each channel.

With single-processor configurations, 6 DIMM slots are available. 6 additional DIMM slots are available with the 2nd CPU & Memory Module.

The CPUs determine the speed at which the memory is clocked. If a 2400MT/s capable CPU is used in the system, the maximum speed the memory will run at is 2400MT/s, regardless of the specified speed of the memory.



Supported Components

The Z6 G4 is designed to work ONLY with DDR4 memory. The system will not work with DDR3 memory.

NOTE 2: Z6 G4 configurations that include a 2nd CPU require the HP Z6 Memory Cooling Solution, which is available both CTO (2JA81AV) and AMO (2HW44AA). Z6 G4 configurations that include greater than 32GB total system memory require the HP Z6 Memory Cooling Solution, which is available both CTO (2JA81AV) and AMO (2HW44AA).

NOTE: Factory-configured CTO (xxxxxAV) and aftermarket AMO (xxxxxAA, xxxxAT) HP memory part numbers designated as "2666" will be transitioned to use "2933" speed memory components. This does not affect HP part number availability nor does it affect system performance or operation. All hardware configurations currently supporting HP memory part numbers designated as "2666" have been tested to work with "2933" memory and are fully-supported by HP under standard support terms.

| NVDIMM Memory | | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|---------------|--|-----------------------|---------------|---------------------------|------------------|
| | Intel® Optane™ DC Persistent Memory (DCPMM) | | | | |
| | 128GB (1x128GB) DC Persistent Memory Module | Y | Ν | | 1,2 |
| | 256GB (2x128GB) DC Persistent Memory Configuration | Y | Ν | | 1 |
| | 512GB (4x128GB) DC Persistent Memory Configuration | Y | Ν | | 1,3 |

NOTE 1: Supported only with Xeon 82xx, 62xx, 52xx and 4215 processors.

- a. Available as factory configured in Memory Mode or Storage Mode.
 - i. Microsoft Configured Memory Mode will be available in CQ1 2020
- b. Systems configured with DCPMM memory will operate the memory subsystem at 2666 MT/s.
- c. Operating System Support:
 - i. Windows 10 Pro 64 for Workstations v1903 or later with all updates applied.
 - ii. Linux OS support may be found in the Linux Hardware Support Matrix.
- d. Detailed setup, security and support information may be found in the <u>Intel[®] Optane[™] DC Persistent</u> <u>Memory: Configuration and Setup on HP Z6 G4 and Z8 G4 Workstation</u> white paper.
- e. DCPMM solutions require additional DRAM memory to be included in the solution:
 - i. Systems configured with DCPMM in Memory Mode will include DRAM memory to be used as cache. The amount of included DRAM memory is based on an 8:1 DCPMM to DRAM capacity ratio.
 - ii. Systems configured with DCPMM in Storage Mode will require DRAM System Memory to be ordered separately.
 - iii. DCPMM Memory will report approximately 2% less than advertised capacity .
- f. Total Memory (DCPMM + DRAM) per processor must be <= 1TB or 2TB per dual processor system.
 i. Z8 G4 Note: "M" processors support a total memory limit < =2TB per processors or 4TB per dual
 - processor system
- **NOTE 2:** Option Kit available in CQ1-2020.

NOTE 3: Requires 2^{nd} processor option.

Multimedia and Audio Devices

HP Z6 G4 Workstation

Supported Components

Multimedia and Audio Devices

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes | |
|------------------------------------|-----------------------|---------------|------------------------------|------------------|--|
| Integrated Realtek HD ALC221 Audio | Y | Ν | | | |

Optical and Removable Storage

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|-----------------------|------------|---------------------------|------------------|
| HP SlimTray Optical Drives | | | | |
| HP 9.5mm Slim Blu Ray Disc Writer | Y | Y | K3R65AA | |
| HP 9.5mm Slim DVD ROM | Y | Y | K3R63AA | |
| HP 9.5mm Slim DVD Writer | Y | Y | K3R64AA | |
| HP Half Height Optical Drives | | | | |
| HP HH DVD Writer (16X RW DVD-R) | Ν | Y | 4AR67AA | |
| HP SD Card Reader | | | | |
| HP SD 4 Card Reader | Y | Y | YOL99AA | |
| HDD Frame/Carriers | | | | |
| HP DX175 Removable HDD Carrier | Ν | Y | 1ZX72AA | |
| HP DX175 Removable HDD Frame/Carrier | Ν | Y | 1ZX71AA | |
| NVMe Frame/Carrier | | | | |
| HP QX310 Removable NVMe Frame/Carrier w/PCIe card | Y | Ν | 8GQ89AA/AT | |
| HP QX310 Removable Carrier only | Ν | Y | 8GQ91AA/AT | |

Actual speeds may vary. No support for DVD-RAM (DVD Writer). Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

With Blu-ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

Option Kit Part Factory Option Configured Kit Number Support Notes HP i350-T2 PCIe Dual Port Gigabit NIC Υ Υ V4A91AA Intel[®] i350-T4 PCIe 4-Port Gigabit NIC γ W8X25AA Ν Intel® Ethernet I210-T1 PCIe x1 Gb NIC Υ Υ E0X95AA Aquantia® NBASE-T 5GbE PCIe NIC Ν γ 1PM63AA Y γ HP Dual Port 10GBase-T NIC Module 1QL49AA Intel[®] 8265 802.11 a/b/g/n/ac + BT PCIe WLAN Ν γ 1QL48AA

Networking and Communications



Supported Components

| Intel® X550-T2 10GbE Dual Port NIC | Y | Y | 1QL46AA | |
|--|---|---|---------|---|
| Intel [®] X710-DA2 10GbE SFP+ Dual Port NIC | Y | Y | 1QL47AA | 1 |
| HP 10GbE SFP+ SR Transceiver | Y | Y | C3N53AA | |
| Intel® Wi-Fi 6 AX200 & BT PCIe | Ν | Y | 7CE01AA | 1 |
| | | | | |

Note 1: Windows 7 is NOT supported

Racking and Physical Security



Supported Components

Racking and Physical Security

| Factory Configured | Option Kit | Option Kit Part Number | Support Notes | |
|-----------------------|----------------------------------|-------------------------------------|---|---|
| Y | Ν | | | |
| Y | Ν | | | |
| Ν | Y | 2HW42AA | | |
| Ν | Y | T1A62AA | | |
| | Configured Y Y N | Configured Kit Y N Y N N Y | Factory ConfiguredOption KitKit Part NumberYNYNYNNY2HW42AA | Factory ConfiguredOption KitKit Part NumberSupport NotesYNYNYNNYNY2HW42AA |

Input Devices

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|-----------------------|---------------|------------------------------|------------------|
| HP Wireless Business Slim Keyboard and Mouse | Y | Y | N3R88AA | |
| Business Slim PS/2 Wired Keyboard | Y | Y | N3R86AA | |
| USB Business Slim Wired Keyboard | Y | Y | N3R87AA | |
| USB Premium Wired Keyboard | Y | Y | Z9N40AA | |
| USB Wired SmartCard CCID Keyboard | Y | Y | E6D77AA | |
| 3Dconnexion CADMouse | Y | Y | M5C35AA | |
| HP Optical USB Mouse | Y | Y | QY777AA | |
| HP PS/2 Mouse | Y | Y | QY775AA | |
| HP USB Hardened Mouse | Y | Y | P1N77AA | |

Other Hardware

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|---|-----------------------|------------|------------------------------|---------------|
| HP ENERGY STAR [®] Certified Configuration | Y | | | |
| HP Z Premium Front I/O 2xUSB-A 2xUSB-C | Y | Y | 1XM32AA | |
| HP Z6 G4 Memory Cooling Solution | Y | Y | 2HW44AA | Note 1 |
| HP Internal USB Port Kit | Ν | Y | EM165AA | Note 2 |
| HP eSATA 2 port PCI Bulkhead Kit | Y | Y | GM110AA | |
| HP Serial Port Adapter | Y | Y | PA716A | |
| HP Workstation Mouse Pad | Y | | | |

Note 1: Z6 G4 configurations that include a 2nd CPU require the HP Z6 Memory Cooling Solution, which is available both CTO (2JA81AV) and AMO (2HW44AA). Z6 G4 configurations that include greater than 32GB total system memory require the HP Z6 Memory Cooling Solution, which is available both CTO (2JA81AV) and AMO (2HW44AA).

Note 2: The HP Internal USB Port kit has a single USB 2.0 type A connector.

| Software | | Option Kit | | | |
|----------|------------------------|-----------------------|------------|----------------|---------------|
| | | Factory Configured | Option Kit | Part Number | Support Notes |
| | Sobey Video Editing SW | Y | Ν | | |



Supported Components

| SW HP RGS for Z | Y | Ν |
|------------------------|---|---|
| HP Sure Start Gen3 | Y | Ν |
| HP Performance Advisor | Y | Ν |



Supported Components

Operating Systems

HP Z6 G4 Workstation

| | Support Notes |
|--|---------------|
| Windows 10 Pro 64 | |
| Windows 7 Professional 64-bit | |
| Windows 10 Downgrade to Windows 7 | |
| HP Linux [®] Installer Kit | Note 2 |
| Red Hat® Enterprise Linux® (RHEL) Workstation - Paper License (1yr) | Note 1 |
| NOTE 1: This second OS must be ordered with the HP Linux [®] Installer Kit as the first | 0S. |
| | |

NOTE 2: includes drivers for 64-bit OS versions of RHEL 6 & 7, SUSE Linux[®] Enterprise Desktop 11 and Ubuntu 14.04. For detailed Linux[®] OS/hardware support information, see: http://www.hp.com/support/linux_hardware_matrix

For detailed Windows 7 OS hardware support information see http://h10032.www1.hp.com/ctg/Manual/c05857891.pdf. Intel Xeon® SP Processors: Platinum 8100, Gold 6100, Gold 5100, Silver 4100, & Bronze 3100 Family support Microsoft Windows 7 Professional 64-bit.



System Technical Specifications

System Board

| System Board Form Factor | Main System Board: 24 x 31 cm 9.6 x 12.2 inches |
|-----------------------------|---|
| | 2nd CPU/Memory Board (optional): |
| | 14.9 x 29.2 cm |
| | 5.85 x 11.50 inches |
| Processor Socket | FCLGA3647 (Socket P) |
| | 1st CPU on system board |
| | 2nd CPU on optional 2nd CPU/Memory Module |
| CPU Bus Speed | UPI: Up to 10.4GT/second, depending on processor |
| Chipset | Intel® C622 Chipset |
| Super I/O Controller | Nuvoton SIO15 |
| Memory Expansion Slots | 6 on system board (CPUO) + 6 on optional 2nd CPU/Memory Module (CPU1) |
| Memory Type Supported | DDR4 R-DIMM (Registered), ECC: 8GB, 16GB, 32GB, and 64GB |
| Memory Modes | NUMA (Non-Uniform Memory Architecture), Memory Node Interleave |
| Memory Speed Supported | 2133MT/s, 2400MHz, 2666MT/s, and 2933MT/s |

Available Memory Configurations:

| | | | Single P | ocessor | | | | |
|----------|-------|------------------------|----------|---------|-------|-------|----------------|--|
| | | | CP | U O | | | | |
| _ | | Top Slots Bottom Slots | | | | | | |
| Capacity | DIMM1 | DIMM2 | DIMM3 | DIMM4 | DIMM5 | DIMM6 | Perf Rating | |
| 8 GB | 8 GB | | | | | | Fair | |
| 16 GB | 8 GB | | | | | 8 GB | Good | |
| 24 GB | 8 GB | 8 GB | 8 GB | | | | Better | |
| 32 GB | 8 GB | | 8 GB | 8 GB | | 8 GB | Better | |
| 32 UD | 16 GB | | | | | 16 GB | Good | |
| 48 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | Best | |
| 40 UD | 16 GB | 16 GB | 16 GB | | | | Better | |
| 64 GB | 16 GB | | 16 GB | 16 GB | | 16 GB | Better | |
| 04 UD | 32 GB | | | | | 32 GB | Good | |
| 96 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | Best | |
| 90 GD | 32 GB | 32 GB | 32 GB | | | | Better | |
| 128 GB | 32 GB | | 32 GB | 32 GB | | 32 GB | Better | |
| 192 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | Best | |
| 256 GB | 64 GB | | 64 GB | 64 GB | | 64 GB | Better | |
| 384 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | Best | |

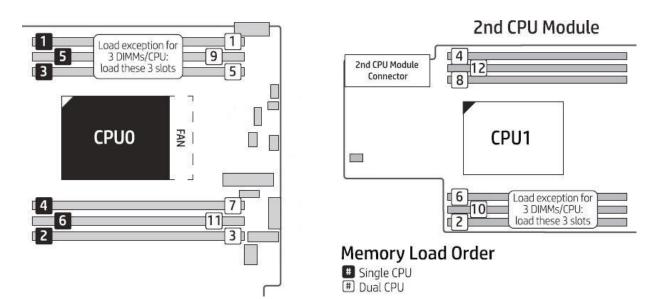


| | | | | | | Dual Pr | ocessor | i i | | | | | |
|----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|--------------|-----------|--------|
| | | | CP | U 0 | | | CPU 1 | | | | | | |
| | T | op Slot | s | Bo | ttom Sl | ots | ٦ | op Slot | S | Bo | Bottom Slots | | |
| Capacity | DIMM 1 | DIMM 2 | DIMM 3 | DIMM 4 | DIMM 5 | DIMM 6 | DIMM 1 | DIMM 2 | DIMM 3 | DIMM 4 | DIMM 5 | DIMM 6 | Rating |
| 16 GB | 8 GB | | | | | | 8 GB | | | | | | Fair |
| 32 GB | 8 GB | | | | | 8 GB | 8 GB | | | | | 8 GB | Good |
| 48 GB | 8 GB | 8 GB | 8 GB | | | | 8 GB | 8 GB | 8 GB | | | | Better |
| 64 GB | 8 GB | | 8 GB | 8 GB | | 8 GB | 8 GB | | 8 GB | 8 GB | | 8 GB | Better |
| 04 UD | 16 GB | | | | | 16 GB | 16 GB | | | | | 16 GB | Good |
| 96 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | Best |
| 90 GD | 16 GB | 16 GB | 16 GB | | | | 16 GB | 16 GB | 16 GB | | | | Better |
| 128 GB | 16 GB | | 16 GB | 16 GB | | 16 GB | 16 GB | | 16 GB | 16 GB | | 16 GB | Better |
| 128 GD | 32 GB | | | | | 32 GB | 32 GB | | | | | 32 GB | Good |
| 192 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | Best |
| 192 UD | 32 GB | 32 GB | 32 GB | | | | 32 GB | 32 GB | 32 GB | | | | Better |
| 256 GB | 32 GB | | 32 GB | 32 GB | | 32 GB | 32 GB | | 32 GB | 32 GB | | 32 GB | Better |
| 230 UD | 64 GB | | | | | 64 GB | 64 GB | | | | | 64 GB | Best |
| 384 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | Better |
| 384 UD | 64 GB | 64 GB | 64 GB | | | | 64 GB | 64 GB | 64 GB | | | | Best |
| 512 GB | 64 GB | | 64 GB | 64 GB | | 64 GB | 64 GB | | 64 GB | 64 GB | | 64 GB | Fair |
| 768 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | Good |

System Technical Specifications

Memory Loading Order:

Load Order for Single and Dual Processor Configuration



Supports up to 768 GB DDR4-2933 ECC RAM* (transfer rates up to 2933MT/s) and 384 GB DDR4-2666 ECC **Maximum Memory** RAM (transfer rates up to 2666MT/s). **Memory Configuration** Only Registered ECC DIMMs are supported. (Supported)

Do not install memory modules into memory slots if corresponding processor is not installed.

Dual processor configurations with memory modules installed for only one processor is not supported.

For systems installed with Microsoft Windows 7 (Ultimate, Enterprise or Pro), the maximum accessible Notes system memory is 192GB

*768 GB configuration requires 2 CPUs configuration.

NVDIMM Memory

Intel[®] Optane[™] DC Persistent Memory is available factory configured in the following capacities:

- 128GB (1x128GB) Single Processor Configuration
- 256GB (2x128GB) Single Processor Configuration
- 512GB (4x128GB) Dual Processor Configuration •

NOTES:

- Supported only with Xeon 82xx, 62xx, 52xx and 4215 processors. 1.
 - a. Available as factory configured in Memory Mode or Storage Mode.
 - i. Microsoft Configured Memory Mode will be available in CQ1 2020
 - b. Systems configured with DCPMM memory will operate the memory subsystem at 2666 MT/s.
 - c. Operating System Support:
 - i. Windows 10 Pro 64 for Workstations v1903 or later with all updates applied.
 - ii. Linux OS support may be found in the Linux Hardware Support Matrix.
 - d. Detailed setup, security and support information may be found in the Intel[®] Optane[™] DC Persistent Memory: Configuration and Setup on HP Z6 G4 and Z8 G4 Workstation white paper.
 - DCPMM solutions require additional DRAM memory to be included in the solution: e.



System Technical Specifications

- i. Systems configured with DCPMM in Memory Mode will include DRAM memory to be used as cache. The amount of included DRAM memory is based on an 8:1 DCPMM to DRAM capacity ratio.
- ii. Systems configured with DCPMM in Storage Mode will require DRAM System Memory to be ordered separately.
- iii. DCPMM Memory will report approximately 2% less than advertised capacity .
- f. Total Memory (DCPMM + DRAM) per processor must be <= 1TB or 2TB per dual processor system.
 - i. Z8 G4 Note: "M" processors support a total memory limit < =2TB per processors or 4TB per dual processor system
- 2. Option Kit available in CQ1-2020.
- 3. Requires 2nd processor option.

PCI Express Connectors Slot 0:

Mechanical-only, for use with devices that require only rear bulkhead mounting or when 2nd CPU riser is installed

Slot 1:

PCI Express Gen3 x4 - CPU with open-ended connector*

Slot 2:

PCI Express Gen3 x16 - CPU

Slot 3:

PCI Express Gen3 x4 - PCH with open-ended connector*

Slot 4:

PCI Express Gen3 x8 – CPU with open-ended connector (slot converts to x4 electrical when SSD is installed in 2nd M.2 slot)*

Slot 5:

PCI Express Gen3 x16 - CPU

Slot 6:

PCI Express Gen3 x4 - PCH with open-ended connector*

M.2 Slot 1:

M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices

M.2 Slot 2:

M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices

* Open-ended connector allows a greater bandwidth (e.g. x16) card to be installed physically into a lower bandwidth connector/slot.

| Supported Drive Interfaces | SATA | 6 SATA @6Gb/s, supports RAID 0, 1, 5, & 10 |
|-------------------------------|----------------------------|---|
| | Serial Attached SCSI | Requires Optional PCIe card |
| | Factory Configured RAID | SATA RAID 0 Striped Array SATA RAID 1 Mirrored Array SATA RAID 10 Striped/Mirrored Notes: Factory integrated Intel® SATA RAID is Microsoft Windows only. |



| | External SATA (eSATA) | Supported on all SATA ports configurable with optional eSATA* cable kit * hot plug / hot swap not supported with eSATA |
|---|---|---|
| Network Controller | Integrated Intel® I219LM GbE LAN | Supports the following management functionalities: Intel® AMT11.2, TXT, DASH 1.1, WOL, VLAN, and PXE 2.1 |
| | Integrated Intel X722 for 1GbE | Data rates supported: 1000 Mb/s Compliance IEEE 802.1as/1588v2, 802.1p, 802.1Q, 802.3, 802.3ab, 802.3az, 802.3x Up to 16 UDP/TCP programmable filters Bus architecture: PCIe 3.0 UEFI and PXE Boot ROM support Intel iWARP Support (RDMA) Network transfer rates: 1000BASE-T (full-duplex) 2000 Mb/s Management capabilities: WOL (Excluding Max Power Savings), auto MDI crossover, PXE, Quad Hash filtering, RSS, Advanced cable diagnostics |
| USB Connector(s) | Front | Front I/O Entry: 4 USB 3.1 Gen1 (Left-most Port has Charging Capability) Front I/O Premium: 2x USB 3.1 Gen1, 2x USB 3.1 Gen2 Type-C[™] (Left-most Port has Charging Capability) Charging Ports provide 1.5 Amps @ 5 Volts Standard USB Type A Ports provide 900mA @ 5 Volts USB Type C Ports provide 3 Amps @ 5 Volts and adhere to the Power Delivery 3.0 specification. |
| | Rear | 6 USB 3.1 G1 Type A |
| | | |
| | Internal | 1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1x USB 2.0 dual-port header |
| Integrated Graphics | Internal No | 1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header |
| Integrated Graphics HD Integrated Audio | | 1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header |
| HD Integrated Audio Flash ROM | No Realtek ALC221 Yes | 1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1x USB 2.0 dual-port header |
| HD Integrated Audio Flash ROM CPU Fan Header | No Realtek ALC221 Yes One for each CPU socke | 1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1x USB 2.0 dual-port header |
| HD Integrated Audio Flash ROM CPU Fan Header Rear Chassis Fan Header | No Realtek ALC221 Yes One for each CPU socke r Yes | 1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1x USB 2.0 dual-port header |
| HD Integrated Audio Flash ROM CPU Fan Header Rear Chassis Fan Header Front PCI Fan Header | No Realtek ALC221 Yes One for each CPU socke r Yes Yes | 1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1x USB 2.0 dual-port header |
| HD Integrated Audio Flash ROM CPU Fan Header Rear Chassis Fan Header Front PCI Fan Header CMOS Battery Holder - | No Realtek ALC221 Yes One for each CPU socke r Yes | 1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1x USB 2.0 dual-port header |
| HD Integrated Audio Flash ROM CPU Fan Header Rear Chassis Fan Header Front PCI Fan Header | No Realtek ALC221 Yes One for each CPU socke r Yes Yes Yes Common Criteria EAL4+ FIPS 140-2 Certified TPM Certified products | 1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1x USB 2.0 dual-port header et |
| HD Integrated Audio Flash ROM CPU Fan Header Rear Chassis Fan Header Front PCI Fan Header CMOS Battery Holder - Lithium Integrated Trusted | No Realtek ALC221 Yes One for each CPU socke r Yes Yes Yes Common Criteria EAL4+ FIPS 140-2 Certified TPM Certified products | 1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1 x USB 2.0 dual-port header et • Certified list: |
| HD Integrated Audio Flash ROM CPU Fan Header Rear Chassis Fan Header Front PCI Fan Header CMOS Battery Holder - Lithium Integrated Trusted Platform Module Power Supply Headers Power Switch, Power LED & Hard Drive LED Header | No Realtek ALC221 Yes One for each CPU socke r Yes Yes Yes Common Criteria EAL4+ FIPS 140-2 Certified TPM Certified products https://trustedcomputi Yes Yes | 1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1 x USB 2.0 dual-port header et • Certified list: |
| HD Integrated Audio Flash ROM CPU Fan Header Rear Chassis Fan Header Front PCI Fan Header CMOS Battery Holder - Lithium Integrated Trusted Platform Module Power Supply Headers Power Switch, Power LED & Hard Drive LED Header Clear Password Jumper | No Realtek ALC221 Yes One for each CPU socke r Yes Yes Common Criteria EAL4+ FIPS 140-2 Certified TPM Certified products https://trustedcomputi Yes Yes | 1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1 x USB 2.0 dual-port header et • Certified list: |
| HD Integrated Audio Flash ROM CPU Fan Header Rear Chassis Fan Header Front PCI Fan Header CMOS Battery Holder - Lithium Integrated Trusted Platform Module Power Supply Headers Power Switch, Power LED & Hard Drive LED Header Clear Password Jumper Serial Port | No Realtek ALC221 Yes One for each CPU socke r Yes Yes Common Criteria EAL4+ FIPS 140-2 Certified TPM Certified products https://trustedcomputi Yes Yes Yes | 1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1 x USB 2.0 dual-port header et • Certified list: |
| HD Integrated Audio Flash ROM CPU Fan Header Rear Chassis Fan Header Front PCI Fan Header CMOS Battery Holder - Lithium Integrated Trusted Platform Module Power Supply Headers Power Switch, Power LED & Hard Drive LED Header Clear Password Jumper | No Realtek ALC221 Yes One for each CPU socke r Yes Yes Common Criteria EAL4+ FIPS 140-2 Certified TPM Certified products https://trustedcomputi Yes Yes | 1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1 x USB 2.0 dual-port header et • Certified list: |



System Technical Specifications

Hood Lock HeaderYesHood Sensor HeaderYesMemory Fan1 Memory Fan Header per CPUAUX IN (audio)No

| Z6 Required Power Supply Info | | | | | |
|--|---|---|--|--|--|
| Power Supply | 1000W 90% Efficient, Custom PSU (Wide Ranging, Active PFC) | | | | |
| Operating Voltage Range | 90–269 V | AC | | | |
| Rated Voltage Range | 100-127 VAC 118 VAC 200-240 VAC | | | | |
| Rated Line Frequency | 50-60 Hz | 400 Hz | | | |
| Operating Line Frequency Range | 47-66 Hz | 393-407 Hz | | | |
| Rated Input Current | 12 A @ 100-127 VAC 6.3 A @ 200-240 VAC | 12A @ 118 VAC | | | |
| Heat Dissipation (Configuration and software dependent) | Typical = 2467 Maximum = 417 | | | | |
| Power Supply Fan | 80x25 mm varia | ble speed | | | |
| ENERGY STAR [®] Qualified (Configuration dependent) | Yes | Yes | | | |
| 80 PLUS® Compliant | Yes, 90% Eff The Z6 G4 1000W power supply efficien https://plugloadsolutions.com 1K0P1A_1000W_ECOS%2 | cy report can be found at this link: n/psu_reports/HP_D15- | | | |
| FEMP Standby Power Compliant @115V (<1W in S5 – Power Off) | Yes | | | | |
| EuP Compliant @ 230V (<0.5 W in S5 – Power Off) | Yes | | | | |
| CECP Compliant @ 220V (<4W in S3 – Suspend to RAM) | Yes; Configuration | dependent | | | |
| Power Consumption in sleep mode (as defined by ENERGY STAR®) – Suspend to RAM (S3) (Instantly Available PC) | <= 20W | I | | | |
| Built-in Self Test LED | Yes | | | | |
| Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V) | Yes | | | | |
| Sensor Header | Integrated in Front User Interface (Power 9 Speaker) Cable | Switch, Power LED, HDD LED, | | | |
| Integrated Gigabit Ethernet Clear CMOS Button | Integrated Intel® I219LM GbE LAN Yes | | | | |



System Technical Specifications

System Configuration

| Example Z6 G4 | Processor | 1x Intel Xeon 3104 (Six-core) | | | | | | | | |
|--------------------|-----------------------|---|--------------|-------------|--------------|--------------|-------------|--|--|--|
| Configuration #1 | Memory | 1x 8GB DDR4-2666 (Registered DIMM) | | | | | | | | |
| | Graphics | 1x NVIDIA Quadro P400 | | | | | | | | |
| | Disks / Optical | 1x 500GB SATA 7200 ; 1x Slim DVD-ROM SATA | | | | | | | | |
| | Power Supply | 1000W 90% c | ustom PSU | | | | | | | |
| | Other | NA | | | | | | | | |
| 115 VAC 230 VAC 10 | | | | | | | VAC | | | |
| Energy Consumption | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | | | |
| | Windows Idle (SO) | 54 | .109 | 54. | 586 | 54. | 906 | | | |
| | Windows Busy Typ(SO) | 94.256 | | 94. | 94.275 | | 94.043 | | | |
| | Windows Busy Max (SO) | 95.992 | | 95.268 | | 95.643 | | | | |
| | Sleep (S3) | 6.219 | 6.205 | 6.319 | 6.306 | 6.334 | 6.239 | | | |
| | Off (S5) | 3.354 | 3.343 | 3.521 | 3.341 | 3.350 | 3.342 | | | |
| | Zero Power Mode (ErP) | 0.209 | | 0.388 | | 0.195 | | | | |
| | | 115 | 5 VAC | 230 | VAC | 100 | VAC | | | |
| Heat Dissipation | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | LAN Disabled | LAN Enabled | | | |
| (Btu/hr) | Windows Idle (SO) | 184 | 1.619 | 186.247 | | 187.339 | | | | |
| | Windows Busy Typ(SO) | 321 | .601 | 321 | .666 | 320.875 | | | | |
| | Windows Busy Max (SO) | 327 | 7.524 | 325 | .054 | 326 | .334 | | | |
| | Sleep (S3) | 21.219 | 21.171 | 21.561 | 21.516 | 21.611 | 21.287 | | | |
| | Off (S5) | 11.444 | 11.406 | 12.014 | 11.399 | 11.430 | 11.403 | | | |
| | Zero Power Mode (ErP) | 0. | 713 | 1.3 | 323 | 0.6 | 565 | | | |

| Example Z6 G4 | Processor | 1x Intel Xeon 4108 (Eight-core) | | | | | | | | |
|--------------------|-----------------------|---------------------------------------|--------------|-------------|--------------|--------------|-------------|--|--|--|
| Configuration #2 | Memory | 4x 8GB DDR4-2666 (Registered DIMM) | | | | | | | | |
| | Graphics | 1x NVIDIA Quadro P2000 | | | | | | | | |
| | Disks / Optical | 2x 1TB SATA 7200 ; 1x Slim DVDRW SATA | | | | | | | | |
| | Power Supply | 1000W 90% custom PSU | | | | | | | | |
| | Other | ΝΑ | | | | | | | | |
| Energy Consumption | | 115 VAC 230 VAC | | | | | VAC | | | |
| (Watts) | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | | | |
| | Windows Idle (SO) | 61.661 | | 61.531 | | 61.354 | | | | |
| | Windows Busy Typ(SO) | 168.665 | | 167.375 | | 166.535 | | | | |
| | Windows Busy Max (SO) | 166 | 5.097 | 163.682 | | 169.674 | | | | |
| | Sleep (S3) | 7.231 | 7.177 | 7.229 | 7.217 | 7.324 | 7.248 | | | |
| | Off (S5) | 3.376 | 3.366 | 3.527 | 3.512 | 3.354 | 3.350 | | | |
| | Zero Power Mode (ErP) | 0.211 | | 0.386 | | 0.195 | | | | |
| | | 115 VAC | | 230 VAC | | 100 VAC | | | | |
| Heat Dissipation | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | LAN Disabled | LAN Enabled | | | |
| (Btu/hr) | Windows Idle (SO) | 210.387 | | 209.944 | | 209.340 | | | | |



| Windows Busy Typ(SO) | 575 | 5.485 | 571. | .084 | 568 | .217 |
|-----------------------|--------|--------|--------|--------|--------|--------|
| Windows Busy Max (SO) | 576 | 5.959 | 575. | .543 | 578 | .928 |
| Sleep (S3) | 24.672 | 24.488 | 24.665 | 24.624 | 24.989 | 24.730 |
| Off (S5) | 11.519 | 11.484 | 12.034 | 11.983 | 11.443 | 11.430 |
| Zero Power Mode (ErP) | 0. | 720 | 1.3 | 17 | 0.6 | 65 |

| Example Z6 G4 | Processor | 1x Intel Xeon | 6136 (Twelve-c | ore) | | | | |
|--------------------|-----------------------|---------------|------------------|-------------|--------------|--------------|-------------|--|
| Configuration #3 | Memory | 6x 8GB DDR4 | -2666 (Register | red DIMM) | | | | |
| ENERGY STAR | Graphics | 1x NVIDIA Qua | adroP4000 | | | | | |
| QUALIFIED | Disks/Optical | 2x 1TB SATA | 7200 ; 1x Slim [| OVDRW SATA | | | | |
| | Power Supply | 1000W 90% c | ustom PSU | | | | | |
| 1 | Other | NA | | | | | | |
| Energy Consumption | | 115 | 5 VAC | 230 | VAC | 100 | VAC | |
| (Watts) | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | |
| 1 | Windows Idle (SO) | 79 | .074 | 79. | 109 | 79. | 938 | |
| 1 | Windows Busy Typ(SO) | | 324.975 | | 317.991 | | 327.451 | |
| 1 | Windows Busy Max (SO) | 328.268 | | 320.296 | | 329.668 | | |
| 1 | Sleep (S3) | 7.847 | 7.756 | 7.878 | 7.826 | 7.931 | 7.852 | |
| 1 | Off (S5) | 3.353 | 3.348 | 3.535 | 3.489 | 3.373 | 3.355 | |
| 1 | Zero Power Mode (ErP) | 0.206 | | 0.386 | | 0.196 | | |
| | | 115 | 5 VAC | 230 | VAC | 100 | VAC | |
| Heat Dissipation | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | LAN Disabled | LAN Enabled | |
| (Btu/hr) | Windows Idle (SO) | 269 | 9.801 | 269 | .920 | 272 | .748 | |
| | Windows Busy Typ(SO) | 110 | 8.815 | 1084.985 | | 1117.262 | | |
| | Windows Busy Max (SO) | 112 | 0.051 | 1092 | 2.850 | 1124 | 1.827 | |
| 1 | Sleep (S3) | 26.774 | 26.463 | 26.880 | 26.702 | 27.061 | 26.791 | |
| 1 | Off (S5) | 11.441 | 11.426 | 12.061 | 11.904 | 11.509 | 11.447 | |
| 1 | Zero Power Mode (ErP) | 0. | 703 | 1.3 | 817 | 0.6 | 69 | |

| Example Z6 G4 | Processor | 2x Intel Xeon 8160 (Dual 24-core) | | | | | | |
|--------------------|-----------------------|-----------------------------------|---------------------------------------|--------------|--------------|-------------|-------------|--|
| Configuration #4 | Memory | 12x 32GB DDF | 84-2666 (Regi | stered DIMM) | | | | |
| | Graphics | 2x NVIDIA Qua | 2x NVIDIA Quadro P5000 | | | | | |
| | Disks / Optical | 4x 2TB SATA 7 | 4x 2TB SATA 7200 ; 1x Slim DVDRW SATA | | | | | |
| | Power Supply | 1000W 90% c | 1000W 90% custom PSU | | | | | |
| | Other | NA | | | | | | |
| Energy Consumption | | 115 VAC | | 230 VAC | | 100 VAC | | |
| (Watts) | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | |
| | Windows Idle (SO) | 112. | 388 | 115 | .635 | 112 | .102 | |
| | Windows Busy Typ(SO) | 512. | 368 | 490.165 | | 526.905 | | |
| | Windows Busy Max (SO) | 698. | 548 | 673 | .465 | 706 | .461 | |
| 1 | Sleep (S3) | 14.208 | 13.833 | 14.698 | 14.487 | 15.176 | 13.886 | |



System Technical Specifications

| | Off (S5) | 3.511 | 3.418 | 3.575 | 3.570 | 3.509 | 3.412 |
|------------------|-----------------------|-------------|--------------|-------------|-------------|--------------|-------------|
| | Zero Power Mode (ErP) | 0.2 | 87 | 0.3 | 887 | 0.2 | 272 |
| | | 115 | VAC | 230 | VAC | 100 | VAC |
| Heat Dissipation | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | LAN Disabled | LAN Enabled |
| (Btu/hr) | Windows Idle (SO) | 383. | 469 | 394 | .547 | 382 | .492 |
| | Windows Busy Typ(SO) | 1748 | .120 | 1672 | 2.443 | 1797 | 7.800 |
| | Windows Busy Max (SO) | 2383 | .446 | 2297 | 7.863 | 2410 |).445 |
| | Sleep (S3) | 48.478 | 47.198 | 50.150 | 49.430 | 51.781 | 47.379 |
| | Off (S5) | 11.980 | 11.662 | 12.198 | 12.181 | 11.973 | 11.642 |
| | Zero Power Mode (ErP) | 0.9 | 79 | 1.3 | 321 | 0.9 | 28 |

NOTE: Power consumption measurements do not take advantage of the Intel Turbo Boost Technology. As a result, power consumption measurements may be higher.

DECLARED NOISE EMISSIONS

| System Configuration | Processor Info | Intel [®] Xeon [®] Gold 6130 processor 2.1GHz 12C CPU |
|--|----------------|---|
| Graphics Info 1-NVIDIA® Quadro® P400 2GB | | 24GB (3x8GB) DDR4-2666 ECC Memory RDIMMs |
| | | 1-NVIDIA [®] Quadro [®] P400 2GB |
| | | 1-500GB SATA 7200RPM 3.5" HDD / 1-HP 9.5mm Slim Blu Ray Disc Writer |
| | Power Supply | 1000 W |

| Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296) | | Sound Power (LWAd, bels) | Deskside Sound Pressure (LpAm, decibels) |
|--|--|-----------------------------|--|
| | Idle | 3.3 | 15 |
| | Hard drive Operating (random reads) | 3.5 | 18 |

| System Configuration | Processor Info | Intel [®] Xeon [®] Platinum 8168 processor 2.7GHz 24C CPU |
|-----------------------------|----------------|---|
| (Mid-range) Memory Info 960 | | 96GB (6x16GB) DDR4-2666 ECC Memory RDIMMs |
| | Graphics Info | 1-NVIDIA [®] Quadro [®] P6000 24GB |
| | Disks/Optical | 2-4TB 6Gb/s 7200RPM SATA HDD / 1-HP 9.5mm Slim Blu Ray Disc Writer |
| | Power Supply | 1000 W |

| Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296) | | Sound Power (LWAd, bels) | Deskside Sound Pressure (LpAm, decibels) |
|--|--|-----------------------------|--|
| | Idle | 3.8 | 23 |
| | Hard drive Operating (random reads) | 3.9 | 23 |



System Technical Specifications

| System Configuration | Processor Info | 2-Intel [®] Xeon [®] Gold 6136 processor 3.0GHz 12C CPU |
|----------------------|----------------|---|
| (High end) | Memory Info | 192GB (12x16GB) DDR4-2666 ECC Memory RDIMMs |
| | Graphics Info | 1-NVIDIA [®] Quadro [®] P6000 24GB |
| | Disks/Optical | 2-4TB 6Gb/s 7200RPM SATA HDD / 1-HP 9.5mm Slim Blu Ray Disc Writer |
| | Power Supply | 1000 W |

| Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296) | | Sound Power (LWAd, bels) | Deskside Sound Pressure (LpAm, decibels) | |
|--|--|-----------------------------|---|--|
| | Idle | 3.8 | 23 | |
| | Hard drive Operating (random reads) | 3.9 | 24 | |

ENVIRONMENTAL DATA

| Environmental Requirements | Temperature | Operating: 5° to 35° C (40° to 95° F) Non-operating: -40° to 60° C (-40° to 140° F) |
|-------------------------------|------------------------|--|
| | Humidity | Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb |
| | Maximum Altitude | Operating: 3,048 m (10,000 feet) |
| | | Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation |
| | | Non-operating: 9,144 m (30,000 feet) |
| | Shock (non-repetitive) | Operating: ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105g) square: 422 cm/s, 20g |
| | | Vibration Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025g²/Hz |

Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025g²/Hz Non-operating random: 2.0g (rms), 5-500 Hz, up to 0.0150 g²/Hz

Physical Security and Serviceability

| Access Panel | Tool-less Includes system board and memory information. |
|--|--|
| Optical Drive | Tool-less, no carrier or rails required |
| Hard Drives | Tool-less |
| | Optional 5.25" external bay carriers |
| Expansion Cards | Tool-less |
| Processor Socket | 1st socket on main system board. 2nd socket on optional 2nd CPU/Memory Module. |
| Blue User Touch Points | Yes, on primary serviceable components. |
| Color-coordinated Cables and Connectors | Yes |



| Memory | Tool-less |
|---|--|
| System Board | Torx T15 screws |
| | 2nd CPU/Memory Module: Tool-less |
| Front of Computer LEDs | Dual Color Power/Failure LED = Yes |
| - | HDD Activity LED = Yes |
| Configuration Record SW | Yes |
| Over-Temp Warning on Screen | Yes, at POST screen on reboot |
| Restore CD/DVD Set | Yes, restores the computer to its original factory shipping image; can be obtained via HP Support. |
| Dual Function Front Power Switch | Yes, also acts as a reset switch when held for 4 seconds. |
| Padlock Support | Yes |
| | |
| Cable Lock Support | Kensington Cable Lock (optional): Prevents entire system theft and system access. 3mm x 7mm slot at rear of system |
| Universal Chassis Clamp Lock Support | Νο |
| Solenoid Lock and Hood | Access Panel Solenoid Lock: Yes (optional). Activated remotely to prevent system entry. |
| Sensor | Access Panel Intrusion Sensor: Yes (optional). |
| Removable Media Write/Boot Control | Yes, user can prevent the workstation from writing to or booting from removable media. |
| Power-On Password | Yes, prevents an unauthorized person from booting up the workstation |
| Setup Password | Yes, prevents an unauthorized person from changing the workstation configuration |
| 3.3V Aux Power LED on System PCA | Yes |
| NIC LEDs (integrated) | Yes |
| (Green & Amber) | |
| CPUs and Heatsinks Power Supply Diagnostic | CPU heatsink removal requires a T-30 Torx screwdriver. |
| LED | |
| Front Power Button | Yes |
| Rear Power Button | Yes |
| Front Power LED | Yes, white (normal), red (fault) |
| Front Hard Drive Activity LED | Yes, white |
| Front ODD Activity LED | Yes on device |
| Internal Speaker | Yes |
| System/Emergency ROM Flash Recovery | Recovers corrupted system BIOS. |
| Cooling Solutions | Air cooled forced convection |
| Power Supply Fans | 1 - 80 mm x 80 mm x 25 mm (non-serviceable) |
| CPU Heatsink Fan | 1st CPU: 1 - 80mm |
| Memory Fan | Optional 2nd CPU: 1 - 60mm x 25mm Front memory fan: 1 – 80mm x 25mm |
| | Memory duct blower: 1 – 90mm x 25mm 2nd CPU/Memory Module: 1 – 60mm x 25mm |



| Chassis Fans | Front chassis fan : 1 - 120mm x 25mm Rear chassis fan: 1 - 120mm x 25mm |
|--|--|
| HP Vision Diagnostics Offline Edition | HP PC Hardware Diagnostics (UEFI) enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing ESC then F2 upon the PC reboot, and is available as a download from HP Support. |
| Access Panel Key Lock ACPI-Ready Hardware | Yes, side panel barrel keylock (optional from the factory only) Advanced Configuration and Power Management Interface (ACPI). |
| | Allows the system to wake from a low-power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system |
| Trusted Platform Module Chip | Integrated Infineon TPM 2.0. TCG and FIPS 140-2 Certified |
| Integrated Chassis Handles | Yes, Front handle and dedicated rear recess |
| Power Supply | Requires T15 Torx or flat blade screwdriver |
| PCIe Card Retention | Yes, tool-less |
| | Rear (all) |
| | Middle (full-height cards) Front (full-length cards with extender) |
| Flash ROM | Yes |
| Diagnostic Power Switch | |
| LED on board | |
| Clear Password Jumper | Yes |
| Clear CMOS Button | Yes |
| CMOS Battery Holder | Yes |
| DIMM Connectors | Yes |
| | |
| BIOS | |
| BIOS 32-bit Services | Standard BIOS 32-bit Service Directory Proposal v0.4 |
| PCI 3.0 Support | Full BIOS support for PCI Express through industry standard interfaces. |
| АТАРІ | ATAPI Removable Media Device BIOS Specification Version 1.0. |
| BBS | BIOS Boot Specification v1.01. |
| WMI Support | WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications. |
| BIOS Boot Spec 1.01+ | Provides more control over how and from what devices the workstation will boot. |
| BIOS Power On | Users can define a specific date and time for the system to power on. |
| ROM Based Computer | Review and customize system configuration settings controlled by the BIOS. |
| Setup Utility (F10) System/Emergency ROM | Recovers system BIOS in corrupted Flash ROM. |
| Flash Recovery with Video | |
| Replicated Setup | Saves BIOS settings to USB flash device in human readable file (HpSetup.txt). BiosConfigurationUtility.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup). |
| SMBIOS | System Management BIOS 2.8, for system management information. |
| Boot Control | Disables the ability to boot from removable media on supported devices. |
| Memory Change Alert | Alerts management console if memory is removed or changed. |



| Thermal Alert | Monitors the temperature state within the chassis. Three modes: |
|---|--|
| | NORMAL - normal temperature ranges. |
| | • ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. |
| | • SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer |
| | without warning before hardware component damage occurs. |
| Remote ROM Flash | Provides secure, fail-safe ROM image management from a central network console. |
| ACPI (Advanced | Allows the system to enter and resume from low power modes (sleep states). |
| Configuration and Power | Enables an operating system to control system power consumption based on the dynamic workload. |
| Management Interface) | Makes it possible to place individual cards and peripherals in a low-power or powered-off state without |
| | affecting other elements of the system. |
| Oursership To a | Supports ACPI 5.0 for full compatibility with 64-bit operating systems. |
| Ownership Tag Domoto Wakeya (Domoto | A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen. |
| Shutdown | System administrators can power on, restart, and power off a client computer from a remote location. |
| Instantly Available PC | Allows for very low power consumption with quick resume time. |
| (Suspend to RAM - ACPI | |
| sleep state S3) | |
| Remote System | Allows a new or existing system to boot over the network and download software, including the |
| Installation via F12 (PXE | operating system. |
| 2.1) (Remote Boot from | |
| Server) ROM revision levels | Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is |
| | available through an industry standard interface (SMBIOS and WMI) so that management SW |
| | applications can use and report this information. |
| System board revision | Allows management SW to read revision level of the system board. |
| level | Revision level is digitally encoded into the HW and cannot be modified. |
| Start-up Diagnostics | Assesses system health at boot time with selectable levels of testing. |
| (Power-on Self-Test) | |
| Auto Setup when new hardware installed | System automatically detects addition of new hardware. |
| | The system can be booted without a keyboard. |
| Localized ROM Setup | Common BIOS image supports System Configuration Utility (F10 Setup) menus in 14 languages with |
| Localizea Nori Secup | local keyboard mappings. |
| Asset Tag | The user or MIS to set a unique tag string in non-volatile memory. |
| Per-slot Control | Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually. |
| Adaptive Cooling | Control parameters are set according to detected hardware configuration for optimal acoustics. |
| Pre-boot Diagnostics | (Pre-video) critical errors are reported via beeps and blinks on the power LED. |
| Industry Standard | |
| Specification Support | |
| Industry Standard | Revision Supported by the BIOS |
| UEFI Specification | 2.5 |
| Revision | |
| | Advanced Configuration and Power Management Interface, Version 5.0 |
| ATA (IDE) | AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b |
| CD Boot | "El Torito" Bootable CD-ROM Format Specification Version 1.0 |
| EDD | - Enhanced Disk Drive Specification Version 1.1 - BIOS Enhanced Disk Drive Specification Version 3.0 |
| EHCI | Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0 |
| PCI | PCI Local Bus Specification, Revision 2.3 |
| | PCI Power Management Specification, Revision 1.1 |
| | PCI Firmware Specification, Revision 3.0, Draft .7 |



System Technical Specifications

| PCI Express | PCI Express Base Specification, Revision 2.0 |
|-------------|--|
| | PCI Express Base Specification, Revision 3.0 |
| РММ | POST Memory Manager Specification, Version 1.01 |
| SATA | Serial ATA Specification, Revision 1.0a |
| | Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 |
| | Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0 |
| SPD | PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B |
| ТРМ | Trusted Platform Module (TPM) 2.0 (Infineon SLB 9670) |
| | Common Criteria EAL4+ Certified |
| | FIPS 140-2 Certification |
| | TCG TPM Certified products list: |
| | http://www.trustedcomputinggroup.org/certification/tpm-certified-products/ |
| UHCI | Universal Host Controller Interface Design Guide, Revision 1.1 |
| USB | Universal Serial Bus Revision 1.1 Specification |
| | Universal Serial Bus Revision 2.0 Specification |
| | Universal Serial Bus Revision 3.1 Specification |
| SMBIOS | System Management BIOS Reference Specification, Version 2.8 |
| | External BIOS simulator found at: http://csrsml.itcs.hp.com/ |

Social and Environmental Responsibility

| Eco-Label Certifications & Declarations | & This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks: |
|--|---|
| | ENERGY STAR[®] (energy-saving features available on selected configurations-Windows only) US Federal Energy Management Program (FEMP) China Energy Conservation Program The ECO declaration (TED) |
| Batteries | The Z6 G4 is registered EPEAT® Gold in the US and Canada. EPEAT® registration varies by country. See http://www.epeat.net for registration status by country. Search keyword generator on HP's 3 rd party option store for solar generator accessories at http://www.hp.com/go/options The battery in this product complies with EU Directive 2006/66/EC Battery mass: 3g Battery type: Lithium Metal |
| | The battery in this product does not contain: |
| | Mercury greater than 5ppm by weight Cadmium greater than 10ppm by weight Lead greater than 40ppm by weight |
| Restricted Material Usage | e This product meets the material restrictions specified in HP's General Specification for the Environment |
| | HP Inc. is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis |
| Low Halogen Statement | This product is low-halogen except for power cords, external cables and peripherals. Service parts |



obtained after purchase may not be low-halogen.

| End-of-Life Management and Recycling HP Inc. Corporate Environmental Information | HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life. For more information about HP's commitment to the environment: Sustainability Report |
|--|---|
| | Eco-label certifications: http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html |
| Additional Information | ISO 14001 certificate: http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC. Product Disassembly Instructions |
| | Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043. |
| Packaging | HP Workstation product packaging meets the HP's General Specification for the Environment |
| | Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment Does not contain ozone-depleting substances (ODS) Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of |
| | 100 ppm sum total for all heavy metals listed Maximizes the use of post-consumer recycled content materials in packaging materials All packaging material is recyclable All packaging material is designed for ease of disassembly Reduced size and weight of packages to improve transportation fuel efficiency |
| | Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting A multi-unit eco packaging option is available to institutional customers that uses less packaging material or has a lower volume footprint than conventional single-unit packaging. Please contact your sales representative for additional details. |
| Packaging Materials Internal External | Cushions and plastic bags made of low density polyethylene (LDPE). Outer carton, accessories carton, and insert made of corrugated paper board. |
| Manageability Industry Standard Specifications | This product meets the following industry standard specifications for manageability functionality: DASH 1.1 (via Intel[®] LAN on motherboard) |
| Intel® Active Management Intel® Active Management Technology (AMT) 11.2x Technology (AMT) | |
| | An advanced set of remote management features and functionality providing IT administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 11.2x includes the following advanced management functions: • Power Management (on, off, reset, graceful shutdown, sleep and hibernate) • Support in Max Power Savings (Shutdown and Hibernate Modes) • Hardware Inventory (includes BIOS and firmware revisions) • Hardware Alerting |



System Technical Specifications

| | Agent Presence System Defense Filters Serial Over LAN (SOL) USB Redirect (Media Redirection) ME Wake-on-LAN (WOL), even with Maximum Power Savings Enabled DASH 1.1 compliance IPv6 Support Fast Call for Help - a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection Remote Scheduled Maintenance - pre-schedule when the system connects to the IT or service provider console for maintenance. Remote Alerts - automatically alert IT or service provider if issues arise Access Monitor - Provides oversight into Intel® AMT actions to support security requirements PC Alarm Clock Microsoft NAP Support Host Base set-up and configuration Management Engine (ME) firmware roll back Local Time Sync to UTC |
|--|---|
| Intel® vPro™ Technology | Remote Memory Dump Command – Creates memory dump for debug The HP Z6 G4 Workstation supports Intel[®] vPro[™] technology when configured as outlined below: |
| | Intel[®] Xeon[®] processor Scalable Family Intel[®] C622 chipset Intel[®] I219LM GbE LAN |
| Remote Manageability Software Solutions | The HP Z6 G4 Workstation is supported on the following remote manageability software consoles: |
| | LANDesk Management Suite (HP recommended solution) Microsoft System Center Configuration Manager HP Client Automation Enterprise |
| | For questions or support for manageability needs, please visit http://www.hp.com/go/clientmanagement |
| System Software Manager | For questions or support for SSM, please visit: http://www.hp.com/go/ssm |
| Service, Support, and Warranty | On-site Warranty and Service (Note 1): Three-years, limited warranty and service offering delivers on- site, next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3) 8am - 5pm. Global coverage (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering. 24/7 operation will not void the HP warranty. |
| | NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country. NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries. HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/lookuptool. Additional HP Care Pack Services information by product is available at: http://www.hp.com/hps/carepack. Service levels and response times for HP Care Packs may vary depending on your geographic location. |



System Technical Specifications

Product Change Notification

- Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile.
- PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition.
- Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.

Stable & Consistent Offerings

| Global Series SKUs | this breakthrough platf Consistent Offerings are designed and tested to | ent to hardware, software, and solution innovation, HP is proud to introduce orm configuration stability to HP Workstation customers. HP Stable & e built on the foundation of a carefully chosen set of hardware and software work with all HP Z Workstation platforms through their end of life. These orresponding HP Workstation platform compatibility are outlined in this | | |
|----------------------------------|--|--|--|--|
| Stable & Consistent Offerings | HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost-no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product. | | | |
| Processors | Product # | Offering | | |
| | 2DL32AV | Intel [®] Xeon [®] Gold 6128 processor | | |
| | 2DL32AV, 1XM44AA | Intel [®] Xeon [®] Gold 6128 2 nd processor | | |
| | 2DL22AV | Intel [®] Xeon [®] Silver 4114 processor | | |
| | 2DL22AV, 1XM49AA | Intel [®] Xeon [®] Silver 4114 2nd processor | | |
| | 2DL18AV | Intel® Xeon® Silver 4108 processor | | |
| | 2DL18AV, 1XM51AA | Intel [®] Xeon [®] Silver 4108 2 nd processor | | |
| Hard Drives | Product # | Offering | | |
| | Z5H22AV, LQ037AA | 1TB SATA 7200 RPM 3.5" HDD | | |
| Graphics | Product # | Offering | | |
| | 2TF08AA | AMD Radeon™ Pro WX 3100 4GB Graphics | | |
| | | | | |
| Memory | Product # | Offering | | |
| | TBD | TBD | | |
| Optical and Removable | Product # | Offering | | |
| Storage | TBD | TBD | | |
| | | | | |



Technical Specifications - Processors

Intel[®] Xeon[®] W-3200 Series CPU

Intel[®] Xeon[®] W-3245 3.2 2933 16C processor Intel® Xeon® W-3235 3.3 2933 12C processor Intel® Xeon® W-3225 3.7 2666 8C processor Intel® Xeon® W-3223 3.5 2666 8C processor Intel[®] Xeon[®] Scalable CPU Intel[®] Xeon[®] Platinum 8280 processor Intel[®] Xeon[®] Platinum 8260 processor Intel[®] Xeon[®] Platinum 8180 processor Intel[®] Xeon[®] Platinum 8160 processor Intel[®] Xeon[®] Gold 6258R processor Intel[®] Xeon[®] Gold 6254 processor Intel[®] Xeon[®] Gold 6252 processor Intel[®] Xeon[®] Gold 6248R processor Intel[®] Xeon[®] Gold 6248 processor Intel[®] Xeon[®] Gold 6246R processor Intel[®] Xeon[®] Gold 6244 processor Intel[®] Xeon[®] Gold 6242R processor Intel[®] Xeon[®] Gold 6242 processor Intel[®] Xeon[®] Gold 6240R processor Intel[®] Xeon[®] Gold 6240Y processor Intel[®] Xeon[®] Gold 6240 processor Intel[®] Xeon[®] Gold 6238R processor Intel[®] Xeon[®] Gold 6230R processor Intel[®] Xeon[®] Gold 6230 processor Intel[®] Xeon[®] Gold 6226R processor Intel[®] Xeon[®] Gold 6226 processor Intel[®] Xeon[®] Gold 6152 processor Intel[®] Xeon[®] Gold 6154 processor Intel[®] Xeon[®] Gold 6148 processor Intel[®] Xeon[®] Gold 6146 processor Intel[®] Xeon[®] Gold 6144 processor Intel[®] Xeon[®] Gold 6142 processor Intel[®] Xeon[®] Gold 6140 processor Intel® Xeon® Gold 6138 processor Intel[®] Xeon[®] Gold 6136 processor Intel[®] Xeon[®] Gold 6134 processor Intel[®] Xeon[®] Gold 6132 processor Intel[®] Xeon[®] Gold 6130 processor Intel[®] Xeon[®] Gold 6128 processor Intel[®] Xeon[®] Gold 5222 processor Intel[®] Xeon[®] Gold 5220R processor Intel[®] Xeon[®] Gold 5220 processor Intel[®] Xeon[®] Gold 5218R processor



Technical Specifications - Processors

Intel[®] Xeon[®] Gold 5218 processor Intel[®] Xeon[®] Gold 5215 processor Intel[®] Xeon[®] Gold 5120 processor Intel[®] Xeon[®] Gold 5118 processor Intel[®] Xeon[®] Gold 5115 processor Intel[®] Xeon[®] Gold 5122 processor Intel[®] Xeon[®] Gold 4216 processor Intel[®] Xeon[®] Gold 4215 processor Intel[®] Xeon[®] Gold 4214R processor Intel[®] Xeon[®] Gold 4214Y processor Intel[®] Xeon[®] Gold 4214 processor Intel[®] Xeon[®] Gold 4210R processor Intel[®] Xeon[®] Gold 4210 processor Intel[®] Xeon[®] Gold 4208 processor Intel[®] Xeon[®] Silver 4116 processor Intel[®] Xeon[®] Silver 4114 processor Intel[®] Xeon[®] Silver 4112 processor Intel[®] Xeon[®] Silver 4110 processor Intel[®] Xeon[®] Silver 4108 processor Intel[®] Xeon[®] Bronze 3206R processor Intel[®] Xeon[®] Gold 3204 processor Intel[®] Xeon[®] Bronze 3106 processor Intel[®] Xeon[®] Bronze 3104 processor



STORAGE/HARD DRIVES

| HP SAS (Serial Attached SCSI) Hard Drives for HP | HP 300GB SAS 15K SFF HDD | Capacity Height | 300GB 5.9 in; 15 cm | |
|---|-----------------------------|--|----------------------------|------------------|
| Workstations | | Width | Media Diameter | 3.5 in; 8.9 cm |
| | | Interface | 12Gb/s SAS | |
| | | Synchronous Transfer Rate (Maximum) | Up to 1200 MB/s (SAS si | ingle port)* |
| | | Buffer | 128MB | |
| | | Seek Time (typical reads, includes controller overhead, including settling) | Average | 2.0ms * |
| | | Rotational Speed | 15K rpm | |
| | | Operating Temperature | 41° to 131° F (5° to 55° (| C) |
| | | *Actual performance may | /ary. | |
| | HP 1.2TB SAS 15K SFF HDD | Capacity | 1.2TB | |
| | | Height | 0.6 in; 1.53 cm | |
| | | Width | Media Diameter | 2.5 in; 6.36 cm |
| | | | Physical Size | 2.75 in; 6.99 cm |
| | | Interface | SAS 6Gb/s | |
| | | Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | |
| | | Buffer | 64MB | |
| | | Seek Time (typical reads, | Single Track | 0.18ms (max)* |
| | | includes controller | Average | 3.5ms* |
| | | overhead, including settling) | Full Stroke | 7.17ms* |
| | | *Actual performance may | vary. | |



| SATA (Serial ATA) Hard | 500GB SATA 7200 rpm | Capacity | 500GB | |
|------------------------|---|---|--|------------------|
| Drives for HP | 6Gb/s 3.5" HDD | Height | 1 in; 2.54 cm | |
| Workstations | | Width | Media Diameter | 3.5 in; 8.9 cm |
| | | | Physical Size | 4 in; 10.17 cm |
| | | Interface | Serial ATA (6.0Gb/s), N | CQ enabled |
| | | Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | |
| | | Buffer | 16MB | |
| | | Seek Time (typical reads, | Single Track | 2 ms* |
| | | includes controller overhead, including settling) | Average Full Stroke | 11 ms* 21 ms* |
| | | Rotational Speed | 7,200 rpm | |
| | | Logical Blocks | 976,773,168 | |
| | | Operating Temperature | 41° to 131° F (5° to 55° | C) |
| | | *Actual performance may | - | 2, |
| | | needat performance may | | |
| | 1TB SATA 7200 rpm | Capacity | 1TB | |
| | 6Gb/s 3.5" HDD | Height | 1 in; 2.54 cm | |
| | | Width | Media Diameter | 3.5 in; 8.9 cm |
| | | | Physical Size | 4 in; 10.17 cm |
| | | Interface | Serial ATA (6.0Gb/s), N | CQ enabled |
| | | Synchronous Transfer Rate (Maximum) | Up to 600 MB/s* | |
| | | Buffer | 64MB | |
| | | Cache | Adaptive | |
| | | Seek Time (typical reads, | Single Track | 2 ms* |
| | | includes controller overhead, including | Average | 11 ms* |
| | | settling) | Full Stroke | 21 ms* |
| | | Rotational Speed | 7,200 rpm | |
| | | Operating Temperature | 41° to 131° F (5° to 55° | C) |
| | | *Actual performance may | vary. | |
| | | a b | | |
| | 2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD CMR | Capacity | 2.0TB | |
| | | Height | 1 in; 2.54 cm | |
| | | Width | Media Diameter | 3.5 in; 8.9 cm |
| | | Interface | Physical Size Serial ATA (6.0 Gb/s), N | 4 in; 10.17 cm |
| | | Synchronous Transfer | Up to 600 MB/s* | |
| | | Rate (Maximum) | | |
| | | Buffer | 64MB | |
| | | Seek Time (typical reads, | Single Track | 1.0 ms* |
| | | includes controller overhead, including | Average | 11 ms* |
| | | settling) | Full Stroke | 18 ms* |
| | | Rotational Speed | 7,200 rpm | |



HP Z6 G4 Workstation

| | Logical Blocks Operating Temperature *Actual performance may | | C) |
|---|--|---|-------------------------------------|
| 2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD SMR | Capacity Height Width | 2.0TB 1 in; 2.54 cm Media Diameter Physical Size | 3.5 in; 8.9 cm 4 in; 10.17 cm |
| | Interface | Serial ATA (6.0 Gb/s), N | |
| | Synchronous Transfer Rate (Maximum) | Up to 600 MB/s* | |
| | Buffer | 64MB | |
| | Seek Time (typical reads, includes controller overhead, including settling) | Single Track Average Full Stroke | 1.2 ms* 12 ms* 21 ms* |
| | Rotational Speed | 7,200 rpm | |
| | Logical Blocks | 3,907,029,168 | |
| | Operating Temperature | 41° to 140° F (5° to 60° | C) |
| | *Actual performance may | vary. | |
| 3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD | Capacity Height | 3.0TB 1 in; 2.54 cm | |
| | Width | Media Diameter | 3.5 in; 8.9 cm |
| | | Physical Size | 4.0 in; 10.17 cm |
| | Interface | Serial ATA (6.0Gb/s), NO | Q enabled |
| | Synchronous Transfer Rate (Maximum) | Up to 6.0 Gb/s* | |
| | Buffer | 64MB | |
| | Seek Time (typical reads, includes controller overhead, including settling) | Single Track Average Full Stroke | 0.6 ms* 11 ms* Not Specified* |
| | Rotational Speed | 7,200 rpm | |
| | Operating Temperature | 41° to 140° F (5° to 60° | C) |
| | *Actual performance may | vary. | |

| 1TB SATA 7200 rpm | Capacity | 1TB | | |
|--------------------|---|---------------------------|----------------|--|
| 6Gb/s 3.5" HDD | Protocol | SATA | | |
| (Enterprise Class) | Form Factor | 3.5" | | |
| | Controller | AHCI | | |
| | Reliability (MTBF) | 2.0M hours | | |
| | Rated Power On Hours | 8760/yr | | |
| | Annualized Failure Rate (based on Rated POH) | <0.62% | | |
| | Rated for 24/7/365 operation | YES | | |
| | Physical Size (Height) | 1 in; 2.54 cm | | |
| | Physical Size (Width) | 4 in; 10.17 cm | | |
| | Media Diameter | 3.5 in; 8.9 cm | | |
| | Interface | Serial ATA (6Gb/s), NCQ | enabled | |
| | Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | | |
| | Buffer | 128MB | | |
| | Seek Time (typical reads, | Single Track | 0.32ms* | |
| | includes controller | Average | 7.45ms* | |
| | overhead, including settling) | Full Stroke | 14.2ms* | |
| | Operating Temperature | 41° to 140° F (5° to 60° | C) | |
| | Performance | Sequential Read | up to 226MB/s* | |
| | | Sequential Write | up to 226MB/s* | |
| | Enterprise Class Features | s High Reliability | | |
| | *Actual performance may | varv | | |

*Actual performance may vary.



| 4TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class) | Capacity Height Width Interface | 4TB 0.275 in; 0.7 cm Media Diameter Physical Size Serial ATA (6Gb/s), NCQ | 2.5 in; 6.36 cm 2.75 in; 6.99 cm enabled |
|---|--|---|--|
| | Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | |
| | Buffer | 128MB | |
| | Seek Time (typical reads, | Single Track | 0.7ms* |
| | includes controller overhead, including | Average | 8.5ms* |
| | settling) | Full Stroke | 15.7ms* |
| | Rotational Speed | 7,200 rpm | |
| | Operating Temperature | 32° to 140° F (0° to 60° (|]) |
| | *Actual performance may | vary. | |
| 500GB SATA 7.2K SED SFF HDD | Capacity Height | 500GB 0.275 in; 0.7 cm | |
| | Width | Media Diameter | 2.5 in; 6.36 cm |
| | | Physical Size | 2.75 in; 6.99 cm |
| | Interface | Serial ATA (6Gb/s) | |
| | Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | |
| | Buffer | 32MB | |
| | Seek Time (typical reads, | Single Track | 1ms* |
| | includes controller | Average | 4.2ms* |
| | overhead, including settling) | Full Stroke | 25ms (typical)* |
| | Rotational Speed | 7,200 rpm | |
| | Operating Temperature | 32° to 140° F (0° to 60° (| <u>[</u>) |
| | *Actual performance may v | vary. | |

| SATA SSDs for HP | HP 256GB SATA 6Gb/s | Capacity | 256GB | |
|------------------|---------------------------------------|--|----------------------------------|-----------------|
| Workstations | SSD | Protocol | SATA | |
| | | Form Factor | 2.5" | |
| | | Controller | AHCI | |
| | | NAND Type | 3D TLC | |
| | | Endurance | 192TBW (TB Written) | |
| | | Reliability (MTTF) | 1.5M hours | |
| | | Physical Size (Height) | 0.28 in; 0.7 cm | |
| | | Physical Size (Width) | 2.5 in; 6.36 cm | |
| | | Interface | SATA 6Gb/s | |
| | | Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | |
| | | Operating Temperature | 32° to 158° F (0° to 70° | ° C) |
| | | Performance | Sequential Read | 530MB/s (max)* |
| | | | Sequential Write | 500MB/s (max)* |
| | | | Random Read | 95K IOPS (max)* |
| | | | Random Write | 83K IOPS (max)* |
| | | *Actual performance may | vary. | |
| | HP 256GB SATA 6Gb/s SED Opal 2 SSD | Capacity | 256GB | |
| | | Protocol | SATA | |
| | | Form Factor | 2.5" | |
| | | Controller | AHCI | |
| | | NAND Type | 3D TLC | |
| | | Endurance | 192TBW (TB Written) | |
| | | Reliability (MTTF) | 1.5M hours | |
| | | Physical Size (Height) | 0.28 in; 0.7 cm | |
| | | Physical Size (Width) | 2.5 in; 6.36 cm | |
| | | Interface | 6Gb/s SATA | |
| | | Synchronous Transfer Rate (Maximum) | Up to 550MB/s (Sequential Read)* | |
| | | Operating Temperature | 32° to 158° F (0° to 70° | ' C) |
| | | Performance | Sequential Read | 530MB/s* |
| | | | Sequential Write | 500 MB/s* |
| | | | Random Read | 95K IOPS* |
| | | | Random Write | 83K IOPS* |
| | | Self-Encrypting Drive Support | OPAL 2 | |
| | | *Actual performance may | vary. | |
| | HP 512GB SATA 6Gb/s | Capacity | 512GB | |
| | SSD | Protocol | SATA | |
| | | Form Factor | 2.5" | |
| | | Controller | AHCI | |
| | | NAND Type | 3D TLC | |
| | | Endurance | 388TBW (TB Written) | |
| | | | | |



| | Reliability (MTTF) | 1.5M hours | |
|-----------------------|--|--------------------------|--------------|
| | Physical Size (Height) | 0.28 in; 0.7 cm | |
| | Physical Size (Width) | 2.5 in; 6.36 cm | |
| | Interface | SATA 6Gb/s | |
| | Synchronous Transfer Rate (Maximum) | Up to 550MB/s (Sequer | itial Read)* |
| | Operating Temperature | 32° to 158° F (0° to 70° | C) |
| | Performance | Sequential Read | 530 MB/s* |
| | | Sequential Write | 500 MB/s* |
| | | Random Read | 95K IOPS* |
| | | Random Write | 83K 10PS* |
| | *Actual performance may v | /ary. | |
| HP 512GB SATA SED SSD | Capacity | 512GB | |
| | Protocol | SATA | |
| | Form Factor | 2.5" | |
| | Controller | AHCI | |
| | NAND Type | 3D TLC | |
| | Endurance | 388TBW (TB Written) | |
| | Reliability (MTTF) | 1.5M hours | |
| | Physical Size (Height) | 0.28 in; 0.7 cm | |
| | Physical Size (Width) | 2.5 in; 6.36 cm | |
| | Interface | SATA 6Gb/s | |
| | Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | |
| | Operating Temperature | 32° to 158° F (0° to 70° | C) |
| | Performance | Sequential Read | 530 MB/s* |
| | | Sequential Write | 500 MB/s* |
| | | Random Read | 95K 10PS* |
| | | Random Write | 83K 10PS* |
| | Self-Encrypting Drive Support | OPAL 1 and 2 | |
| | *Actual performance may v | /ary. | |
| HP 1TB SATA 6Gb/s SSD | Capacity | 1TB | |
| | Protocol | SATA | |
| | Form Factor | 2.5" | |
| | Controller | AHCI | |
| | NAND Type | 3D TLC | |
| | Endurance | 400TBW (TB Written) | |
| | Reliability (MTTF) | 1.5M hours | |
| | Physical Size (Height) | 0.28 in; 0.7 cm | |
| | Physical Size (Width) | 2.5 in; 6.36 cm | |
| | Interface | SATA 6Gb/s | |
| | Synchronous Transfer Rate (Maximum) | Up to 550MB/s (Sequer | itial Read)* |
| | Operating Temperature | 27º to 159º 5 (0º to 70º | \sim |



Operating Temperature 32° to 158° F (0° to 70° C)

| | Performance | Sequential Read Sequential Write | 530 MB/s* 500 MB/s* |
|-----------------------|--|---|------------------------|
| | | Random Read | 95K IOPS* |
| | | Random Write | 83K IOPS* |
| | *Actual performance may v | ary. | |
| HP 2TB SATA 6Gb/s SSD | Capacity | 2TB | |
| | Protocol | SATA | |
| | Form Factor | 2.5" | |
| | Controller | AHCI | |
| | NAND Type | 3D TLC | |
| | Endurance | 400TBW (TB Written) | |
| | Reliability (MTTF) | 1.5M hours | |
| | Physical Size (Height) | 0.28 in; 0.7 cm | |
| | Physical Size (Width) | 2.5 in; 6.36 cm | |
| | Interface | SATA 6Gb/s | |
| | Synchronous Transfer Rate (Maximum) | Up to 550MB/s (Sequen | tial Read)* |
| | Operating Temperature | 32° to 158° F (0° to 70° | C) |
| | Performance | Sequential Read | 530 MB/s* |
| | | Sequential Write | 500 MB/s * |
| | | Random Read | 95K IOPS* |
| | | Random Write | 83K IOPS* |
| | *Actual performance may v | ary. | |
| HP Enterprise Class | Capacity | 240GB | |
| 240GB SATA SSD | Protocol | SATA | |
| | Form Factor | 2.5" | |
| | Controller | AHCI | |
| | NAND Type | 3D TLC | |
| | Endurance | 2,200TBW (TB Written) | |
| | Reliability (MTTF) | 2.0M hours | |
| | Physical Size (Height) | 0.28 in; 0.7 cm | |
| | Physical Size (Width) | 2.5 in; 6.36 cm | |
| | Interface | 6Gb/s SATA | |
| | Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | |
| | Operating Temperature | 32° to 158° F (0° to 70° | C) |
| | Performance | Sequential Read | 540 MB/s* |
| | | Sequential Write | 310 MB/s* |
| | | Random Read | 93K IOPS* |
| | | Random Write | 48K IOPS* |
| | Enterprise Class Features | High Endurance NAND Power Loss Protection End-to-End Data Protect | tion |
| | *Actual performance may v | ary. | |

| | HP Enterprise Class | Capacity | 480GB | |
|---------------------|-------------------------------|-------------------------------|---|--------------------|
| | 480GB SATA SSD | Protocol | SATA | |
| | | Form Factor | 2.5" | |
| | | Controller | AHCI | |
| | | NAND Type | 3D TLC | |
| | | Endurance | 4,400TBW (TB Written) | |
| | | Reliability (MTTF) | 2.0M hours | |
| | | Physical Size (Height) | 0.28 in; 0.7 cm | |
| | | Physical Size (Width) | 2.5 in; 6.36 cm | |
| | | Interface | 6Gb/s SATA | |
| | | Synchronous Transfer | Up to 600MB/s* | |
| | | Rate (Maximum) | op to cool 12/0 | |
| | | Operating Temperature | 32° to 158° F (0° to 70° | C) |
| | | Performance | Sequential Read | 540 MB/s* |
| | | | Sequential Write | 460 MB/s* |
| | | | Random Read | 93K IOPS* |
| | | | Random Write | 74K IOPS* |
| | | Enterprise Class Features | High Endurance NAND Power Loss Protection End-to-End Data Prote | ction |
| | | *Actual performance may v | ary. | |
| | | | | |
| Value PCIe SSDs for | HP 256GB M.2 2280 SSD | Capacity | 256GB | |
| HP Workstations | | Protocol | PCIe | |
| | | Form Factor | M.2 | |
| | | Controller | NVMe | |
| | | NAND Type | TLC | |
| | | Endurance | 200TB | |
| | | Reliability (MTBF) | 1.5M hours | |
| | | Interface | PCI Express 3.0 x4 elec | trical x4 physical |
| | | Operating Temperature | 32° to 158° F (0° to 70° | C) |
| | | Performance | Sequential Read | 3100 MB/s * |
| | | | Sequential Write | 1400 MB/s * |
| | | | Random Read | 200K IOPS * |
| | | | Random Write | 320K IOPS * |
| | | *Actual performance may vary. | | |
| | HP 512GB M.2 2280 SSD | Capacity | 512GB | |
| | IIF J I Z UD M.Z Z Z OU J J D | Protocol | PCIe | |
| | | Form Factor | M.2 | |
| | | Controller | NVMe | |
| | | NAND Type | 3D TLC | |
| | | Endurance | 300TB | |
| | | Reliability (MTBF) | 1.5M hours | |
| | | Interface | | trical x4 physical |
| | | | PCI Express 3.0 x4 electrical x4 physical | |

| Operating Temperature | 32° to 158° F (0° to 70° C) | | |
|-------------------------------|-----------------------------|------------|--|
| Performance | Sequential Read 3400 MB/s* | | |
| | Sequential Write | 2500 MB/s* | |
| | Random Read | 380K IOPS* | |
| | Random Write | 430K IOPS* | |
| *Actual performance may vary. | | | |

HP Z Turbo Drive G2 1TB Capacity 1TB SSD Protocol PCle **Form Factor** M.2 Controller NVMe NAND Type 3D TLC 400TB Endurance Reliability (MTTF) 1.5M hours Interface PCI Express 3.0 x4 electrical x4 physical **Operating Temperature** 32° to 158° F (0° to 70° C) Performance **Sequential Read** 3400 MB/s* **Sequential Write** 2500 MB/s* **Random Read** 500K IOPS* **Random Write** 440K IOPS*

*Actual performance may vary.



| Performance PCIe SSDs for HP Workstations | HP Z Turbo Drive Dual Pro 256GB PCIe SSD | Capacity Interface Operating Temperature | 256GB (one M.2 PCIe N PCI Express 3.0 x4 elec 32° to 158°F (0° to 70° | ctrical x4 physical |
|--|---|---|--|---------------------|
| | HP Z Turbo Drive Dual Pro 512GB PCIe SSD | Capacity Interface Operating Temperature | 512GB (one M.2 PCIe N PCI Express 3.0 x4 elec 32° to 158°F (0° to 70° | ctrical x4 physical |
| | HP Z Turbo Drive Dual Pro 1TB PCIe SSD | Capacity Interface Operating Temperature | 1TB (one M.2 PCIe NVM PCI Express 3.0 x4 elec 32° to 158°F (0° to 70° | ctrical x4 physical |
| | HP Z Turbo Drive Dual Pro 2TB PCIe SSD | Capacity Interface Operating Temperature | 2TB (one M.2 PCIe NVM PCI Express 3.0 x4 elec 32° to 158°F (0° to 70° | ctrical x4 physical |
| | HP Z Turbo Drive Quad Pro 2x256GB PCIe SSD | Capacity Protocol Form Factor Controller NAND Type Endurance Reliability (MTBF) Interface Operating Temperature Performance | 512GB PCIe PCIe Card, Full Height I NVMe 3D TLC 200TB 1.5M hours PCIe Gen3 x4 architect 32° to 158° F (0° to 70° Sequential Read Sequential Write Random Read Random Write | ure |
| | HP Z Turbo Drive Quad Pro 2x512GB PCIe SSD | *Actual performance may Capacity Protocol Form Factor Controller NAND Type Endurance Reliability (MTBF) Interface Operating Temperature Performance | 1TB PCIe PCIe Card, Full Height I NVMe 3D TLC 300TB 1.5M hours PCIe Gen3 x4 architect 32° to 158° F (0° to 70' Sequential Read Sequential Write Random Read | ure |



| HP 2 Turbo Drive Quad Capacity 2TB Protocol PCle Form Factor PCle Card, Full Height PC ISIO Controller NVMe NAND Type 20 TLC Endurance 400TB Interface 00 El Card, Full Height PC ISIO Operating Temperature 22*to 158° F (0° to 70° - 7000 Performance Sequential Read 3500 MB/s° Random Read 5800 KI0PS* Performance may restrict Sequential Writer 3000 MB/s° Seguential Kead 5800 KI0PS* Sequential Writer Solok KI0PS* *Actual performance may restrict Sequential Writer Solok KI0PS* *SeGB TLC SED Sand Capacity 256GB TLC SED Sand Protocol NMe NAND Type 3D TLC SED Support 0pal 2 Sequential Writer Sequential Writer Endurance 200 Figers 3.0 x4 electrict x4 physical Sequential Writer | | *Actual performance may | Random Write vary. | 500K IOPS* |
|---|--------------------|-------------------------|-----------------------|-------------|
| Protecol PCIe Form Factor PCIe Card, Full Height PCIe Slot Controller NMMe NAND Type 3D TLC Endurance 400TB Interface PCI Express 3.0 x4 electria x4 physical Operating Temperature 32° to 158° F (0° to 70° C Performance Sequential Read 3000 MB/s* Random Write 500 K IDPS* Random Write 500 K IDPS* Yactual performance may | | | | |
| Form Factor PCle Card, Full Height PCle Slot Controller NVMe NAND Type 3D TLC Endurance 400TB Interface PCle Card, Full Height PCle Slot Operating Temperature 32° to 158° F (0° to 70° C) Performance Sequential Read 3500 MB/s* Sequential Write 3000 MB/s* Random Read 580 K 10PS* Random Write 500K 10PS* *Actual performance may varve 500K 10PS* *S6GB TLC SSD and 256GB TLC SSD and 256GB TLC SSD SD Protocol PCle Cavee Form Factor M.2 Secuential Read 3500 MB/s* SEGGB TLC SSD and SEGGB TLC SSD and SEGGB TLC SSD and SEGGB TLC SSD and 256GB TLC SED SSD Form Factor M.2 Secuential Read 3500 MB/s* Reliability (MTBF) 1.5M hours Interface 9Cle Saport Saport Saport MB/s* Reliability (MTBF) 1.5M hours Interface 32° to 158° F (0° to 70° C) Performance Performance Sequential Read 3500 MB/s* Sequential Read 3500 MB/s* <tr< th=""><th>_</th><th></th><th></th><th></th></tr<> | _ | | | |
| Controller NVMe NAND Type 3D TLC Endurance 400TB Interface PCI Express 3.0 x4 electrical x4 physical Operating Temperature 32° to 158° F (0° to 70° C Performance Sequential Read 3500 MB/s* Random Read 580 K 10PS* Random Read 580 K 10PS* Random Read 580 K 10PS* Z56GB TLC SSD and 256GB 256GB TLC SSD SSD Protocol PCIe Form Factor M.2 SE3 Controller NVMe NAND Type 35E SD Support 0pal 2 SED Support Reliability (MTBF) 1.5M hours Interface Interface PCI Express 3.0 x4 electricat x4 physical Operating Temperature 32° to 158° F (0° to 70° C Performance 200TBW (TB Written) Sequential Read Sido MAPS* Sequential Read 300 MB/s* Random Read 240K 10PS* Random Read 240K 10PS* Random Write 400K 10PS* Random Read 240K 10PS* State Turbo Drive 62 Capacity Si26B Si200 MB | FIU ZATI DECLE JJD | | | |
| NAND Type3D TLCEndurance400TBInterfacePCI Express 3.0 x4 electrical x4 physicalOperating Temperature32* to 158° F (0* to 70* /PerformanceSequential Read3500 MB/s*Sequential Read580 K 10P5*Random Read580 K 10P5*Random Read580 K 10P5*Random Read580 K 10P5*Performance may:566B2556B TLC SSD and256GB256GB TLC SSD andCapacityProtocolPCIeProtocolN/MeForm FactorM.2ControllerN/MeNAND Type3D TLCSED Support0pal 2Endurance200TBW (TB Written)SED Support0pal 2Endurance22* to 158° F (0* to 70* CPerformance may:240 K 10P5*Reliability (MTBF)1.5M hoursInterfacePCI Express 3.0 x4 electrical x4 physicalPerformance22* to 158° F (0* to 70* CPerformanceSequential Read3500 MB/s*Sequential Read3500 MB/s*Sequential Read12 CB TLC SSD and240 K 10P5*12 CB TLC SSD SSDProtocolPerformanceSequential Read3512 GB TLC SSD and240 K 10P5*12 CB TLC SSD and240 K 10P5*12 CB TLC SSD SSDProtocolForm FactorM.2ControllerNVMeNAND Type31 CLS12 GB TLC SSD SSD andSequential Read12 CB TLC SSD SSD andSequential Read | | | - | t PCIe Slot |
| Endurance400TBInterface9C1 Express 3.0 x4 elext - 1 x4 physicalOperating Temperature32° to 158° F (0° to 70° - 7PerformanceSequential Read3000 MB/s*Sequential Read3000 MB/s*Sequential Read500 K105*Random Read500 K105*Tottoo Drive 62Capacity256GBProtocolPCIe | | | | |
| InterfacePCI Express 3.0 x4 ele∪tiol x4 physical 32° to 158° F (0° to 70° ∪PerformanceSequential Read3500 MB/s* Sequential WritePerformanceSequential Write3000 MB/s* Random Read*Actual performance may variableS66 B500 K 10P5* | | | | |
| Operating Temperature 32° to 158° F (0° to 70° C) Performance Sequential Read 3500 MB/s* Random Read 580 K 10P5* Random Write 500K 10P5* Random Write 500K 10P5* *Actual performance may vary. * HP Z Turbo Drive G2 Capacity 256GB 256GB TLC SED SD Protocol PCle Porm Factor M.2 | | | | |
| Performance Sequential Read 3500 MB/s* Sequential Write 3000 MB/s* Random Read 580 K 10PS* Random Write 500K 10PS* *Actual performance may vary. * HP Z Turbo Drive G2 Capacity 256GB 256GB TLC SED SD Protocol PCIe Prom Factor M.2 | | | - | |
| Sequential Write 3000 MB/s* Random Read 580 K 10PS* Random Write 500K 10PS* *Actual performance may vary. * HP Z Turbo Drive G2 256GB TLC SSD and 256GB TLC SSD and 256GB TLC SSD SSD Capacity 256GB Protocol PCle Form Factor M.2 Controller NVMe NAND Type 3D TLC SED Support Opal 2 Endurance 200TBW (TB Written) Reliability (MTBF) 1.5M hours Interface PCIE Express 3.0 x4 electrical x4 physical Operating Temperature 32° to 158° F (0° to 70° C Performance Sequential Read 3500 MB/s* Sequential Sea 200 MB/s* Random Read 240K 10PS* Random Write 480K 10PS* *Actual performance may vary. 200 MB/s* Performance Sequential Read 3500 MB/s* Sequential Write 200 MB/s* Siz6B TLC SSD and 5126B TLC SSD and 5126B TLC SSD and 5126B TLC SED SSD Capacity 5126B Form Factor M.2 | | | - | |
| Random Read \$80 K 10PS* Random Write \$00 K 10PS* *Actual performance may verv * #256GB TLC SSD and 256GB TLC SSD and 256GB TLC SSD SSD Capacity 256GB Protocol PCle Form Factor M.2 Controller NVMe NAND Type 3D TLC SED Support 0pal 2 Endurance 200TBW (TB Written) Form Factor 200TBW (TB Written) Reliability (MTBF) 200TBW (TB Written) Reliability (MTBF) 200TBW (TB Written) Performance 220 MB/s* Random Read 300 MB/s* Sequential Read 300 MB/s* Random Read 240K 10PS* Performance 200 MB/s* Random Read 240K 10PS* St2GB TLC SSD and Protocol St2GB TLC SSD and Protocol St2GB TLC SSD SSD Random Read St2GB TLC SSD SSD Protocol ND Type St2GB St2GB TLC SSD And Protocol St2GB TLC SSD St2 Protocol Performance St2GB St2GB TLC SSD And St2GB St2GB TLC SSD And St2GB St2GB TLC SSD And St2GB St2GB | | Performance | - | |
| HP Z Turbo Drive G2 Capacity 256GB S50 256GB TLC SED SSD Protocol PCle Form Factor M.2 Second Controller NVMe Second NAND Type 3D TLC SED Support Opal 2 Endurance 200TBW (TB Written) Second Second Reliability (MTBF) 1.5M hours Interface Operating Temperature 32° to 158° F (0° to 70° Uritta) Performance Sequential Read 3500 MB/s* Gapacity Performance 2200 MB/s* Random Read 240K IOPS* Turbo Drive G2 Capacity SizeB StizeB TLC SSD and Protocol Sequential Read 3500 MB/s* Random Read 240K IOPS* Random Write 240K IOPS* StizeB TLC SSD and Protocol Protocol Sequential Read 240K IOPS* StizeB TLC SSD and Protocol NUME Random Read 240K IOPS* StizeB TLC SSD and Protocol NUME Sequential Read 240K IOPS* StizeB TLC SSD and Protocol Sequential Read 240K IOPS* <th></th> <th></th> <th>-</th> <th></th> | | | - | |
| *Actual performance may variable in the second of the s | | | | |
| HP Z Turbo Drive G2 256GB TLC SED SSD Capacity 256GB PCIe Form Factor M.2 M.2 Controller NVMe NVMe NAND Type 3D TLC SED Support Opal 2 Endurance 200TBW (TB Written) Reliability (MTBF) 1.5M hours Interface PCI Express 3.0 x4 electrical x4 physical Operating Temperature 32° to 158° F (0° to 70° C) Performance Sequential Read 3500 MB/s* Sequential Read 240K IOPS* Random Write 480K IOPS* Random Write 480K IOPS* *Actual performance may 2200 MB/s* S12GB TLC SSD and S12GB S12GB TLC SSD SD Capacity S12GB Protocol Protocol VMe NAND Type 3D TLC S2 S12GB TLC SSD and S12GB S12GB S12GB TLC SSD and S12GB S12GB S12GB TLC SSD SD Rator MIND Type S12GB TLC SSD SD Gapacity S12GB S12GB Form Factor M.2 S12 Gontroller | | | | 500K IOPS* |
| 256GB TLC SSD and 256GB TLC SED SSD Protocol M.2 Form Factor M.2 Controller NVMe NAND Type 3D TLC SED Support Opal 2 Endurance 200TBW (TB Written) Reliability (MTBF) 1.5M hours Interface PCI Express 3.0 x4 eleettal x4 physical Operating Temperature 32° to 158° F (0° to 70° U Performance Sequential Read 3500 MB/s* Sequential Read 240K 10PS* Performance Sequential Read 240K 10PS* Random Write 430K 10PS* 430K 10PS* *Actual performance may 2200 MB/s* 512GB TLC SSD and 512GB TLC SSD and Capacity 512GB 430K 10PS* Form Factor M.2 - - S12GB TLC SSD and Form Factor M.2 - S12GB TLC SSD and Form Factor M.2 - S12GB TLC SSD and Form Factor M.2 - S12GB TLC SSD and S12G S12G - | | *Actual performance may | vary. | |
| 256GB TLC SED SSD Form Factor 6.12 Controller NAND Type 3D TLC SED Support 0pal 2 Endurance 200TBW (TB Written) Reliability (MTBF) 1.5M hours Interface 0perating Temperature 2° to 158° F (0° to 70° Performance 8equential Read 3500 MB/s* Sequential Write 200 MB/s* 8andom Read 240K IOPS* 8andom Write 480K IOPS* 8andom Write 8and | | Capacity | 256GB | |
| Form FactorM.2ControllerNVMeNAND Type3D TLCSED SupportOpal 2Endurance200TBW (TB Written)Reliability (MTBF)1.5M hoursInterfacePCI Express 3.0 x4 electrical x4 physicalOperating Temperature32° to 158° F (0° to 70° CPerformanceSequential ReadPerformanceSequential Read200 MB/s*Random Read240K IOPS*Random Write480K IOPS**Actual performance matrice matrice matrice7200 MB/s*512GB TLC SSD and 512GB TLC SSD and 512GB TLC SSD and 512GB TLC SSD and 512GB TLC SSD SDCapacityForm FactorM.2KANND Type3D TLCSED SupportOpal 2Form FactorNVMeNAND Type3D TLCSED SupportOpal 2Endurance300TBW (TB Written)Reliability (MTBF)1.5M hoursInterface9CI Express 3.0 x4 electrical x4 physicalOperating Temperature300TBW (TB Written)Reliability (MTBF)1.5M hoursInterface9CI Express 3.0 x4 electrical x4 physicalOperating Temperature32° to 158° F (0° to 70° CForm Facco3.00TBW (TB Written)Reliability (MTBF)1.5M hoursInterface9CI Express 3.0 x4 electrical x4 physicalInterface9CI Express 3.0 x4 electrical x4 physicalInterface9CI Express 3.0 x4 electrical x4 physicalInterface9CI Express 3.0 x4 electrical x4 physicalInterface< | | Protocol | PCIe | |
| NAND Type3D TLCSED SupportOpal 2Endurance200TBW (TB Written)Reliability (MTBF)1.5M hoursInterfacePCI Express 3.0 x4 ele-trial x4 physicalOperating Temperature32° to 158° F (0° to 70°PerformanceSequential Read3500 MB/s*Sequential Read240K IOPS*Random Read240K IOPS*Random Write480K IOPS**Actual performance may22° to 158° F (0° to 70°*Actual performance may240K IOPS*Random Read240K IOPS*S12GB TLC SSD and 512GB TLC SED SSDCapacity512GBProtocolPCle | | Form Factor | M.2 | |
| SED SupportOpal 2Endurance200TBW (TB Written)Reliability (MTBF)1.5M hoursInterfacePCI Express 3.0 x4 electral x4 physicalOperating Temperature32° to 158° F (0° to 70° COperating Temperature32° to 158° F (0° to 70° CPerformanceSequential Read3500 MB/s*Sequential Write2200 MB/s*Sequential Write2200 MB/s*Random Read240K IOPS*Random Write480K IOPS**Actual performance may:480K IOPS**Actual performance may:512GBProtocolPCleForm FactorM.2ControllerNVMeNAND Type30 TLCSED Support0pal 2Endurance300TBW (TB Written)Reliability (MTBF)1.5M hoursInterfacePCI Express 3.0 x4 electral x4 physicalInterface9C1 Express 3.0 x4 electral x4 physicalOperating Temperature3° 00TBW (TB Written)Performance300TBW (TB Written)Form Factor1.5M hoursForm Factor300TBW (TB Written)SED Support300TBW (TB Written)SED Support300TBW (TB Written)Ferdiability (MTBF)1.5M hoursInterface9C1 Express 3.0 x4 electral x4 physicalOperating Temperature2° to 158° F (0° to 70° CPerformance800TBW (TB Written)Performance3° to 158° F (0° to 70° CPerformance800TBW (TB Written)Performance3° to 158° F (0° to 70° CPerf | | Controller | NVMe | |
| Endurace200TBW (TB Written)Reliability (MTBF)1.5M hoursInterfacePCI Express 3.0 x4 electral x4 physicalOperating Temperature32° to 158° F (0° to 70° CPerformanceSequential Read3500 MB/s*Sequential Write2200 MB/s *Random Read240K 10PS*Random Write480K 10PS**Actual performance may240K 10PS**Actual performance may240K 10PS*\$12GB TLC SSD andProtocolProtocolPCleForm FactorM.2ControllerNVMeNAND Type3D TLCSED Support0pal 2Endurance300TBW (TB Written)Reliability (MTBF)1.5M hoursInterface9Cl Express 3.0 x4 electral x4 physicalOperating Temperature300TBW (TB Written)ProtocolSED SupportSED Support0pal 2Endurance300TBW (TB Written)Interface9Cl Express 3.0 x4 electral x4 physicalOperating Temperature32° to 158° F (0° to 70° CPerformance800TBW (TB Written)Performance300TBW (TB Written)Performance300TBW (TB Written)Performance32° to 158° F (0° to 70° CPerformance300TBW (TB Written)Protocol1.5M hoursProtocol1.5M hoursProtocol300TBW (TB Written)Protocol200TBW (TB Written)Protocol300TBW (TB Written)Protocol200TBW (TB Written)Protocol200TBW (| | NAND Type | 3D TLC | |
| Reliability (MTBF)1.5M hoursInterfacePCI Express 3.0 x4 0 ± 3.5 ± 3 | | SED Support | • | |
| InterfaceCl Express 0.44 eU-34 eV-34 eV-34 3° to 158° F(0° to 70° -PerformanceSequential Read300 MS/s °PerformanceSequential Read200 MS/s °Sequential Write200 MS/s °200 MS/s °Random Read240K 10PS °200 MS/s °Nettra Derformance512GE TUS SSD °300 MS/s °ProtocolS12GE TUS SSD °ProtocolS12GE CUS SSD °Form FactorN2Form FactorN2KAND TypeSD 12G CUS SSD °SED SupportS12GE CUS SSD °MAND TypeS12GE CUS SSD °SED SupportS12GE CUS SSD °MAND TypeS12GE CUS SSD °SED SupportS12GE CUS SSD °MandreeS12GE SUP SSD °SED SupportS12GE SUP SSD °MAND TypeS12GE SUP SSD °SED SupportS12GE SUP SSD °MandreeS12GE SUP SSD °SED SUP SSD °S12GE SUP SSD °MandreeS12GE SUP SSD °S12GE SUP SSD °S12GE SUP SSD °MandreeS12GE SUP SSD SSD °S12GE SUP SSD °S12GE SUP SSD °MandreeS12GE SUP SSD SSD °S12GE SUP SSD °S12GE SUP SSD °MandreeS12GE SUP SSD SSD °S12GE SUP SSD °S12GE SUP SSD °MandreeS12GE SUP SSD °S12GE SUP SSD °S12GE SUP SSD °MandreeS12GE SUP SSD °S12GE SUP SSD °S12GE SUP SSD °MandreeS12GE SUP SSD °S12GE SUP SSD °S12GE SUP SSD °MandreeS12GE SUP SSD °S12GE SUP SSD °S12GE SUP SSD ° | | | 200TBW (TB Written |) |
| Operating Temperature Performance32° to 158° F (0° to 70° C) Sequential Read Sequential Read | | | 1.5M hours | |
| PerformanceSequential Read3500 MB/s*Sequential Write2200 MB/s*Sequential Write2200 MB/s*Random Read240K 10PS*Random Write480K 10PS**Actual performance may-vary.480K 10PS**Actual performance may-vary.512GBS12GB TLC SSD and S12GB TLC SED SSDCapacityProtocol512GBProtocolPCleForm FactorM.2ControllerNVMeNAND Type3D TLCSED Support0pal 2Endurance300TBW (TB Written)Reliability (MTBF)1.5M hoursInterfacePCl Express 3.0 x4 ele:-tal x4 physicalOperating TemperatureSequential ReadSto MB/s*Sequential ReadSequential Read3500 MB/s* | | | - | |
| Sequential Write2200 MB/s*Random Read240K 10PS*Random Write480K 10PS**Actual performance may480K 10PS**Actual performance may512GBProtocol512GBProtocol9CleForm FactorM.2ControllerNVMeMAND Type3D TLCSED Support0pl 2Reliability (MTBF)1.5M hoursInterface021Express 0.54 cellOperating Temperation212Express 0.54 cellPerformanceSequential ReadedSequential Readed3012W - 112 cellSequential Readed512Express 0.54 cellSequential Readed512Express 0.55 cellSequenti | | | | |
| HP Z Turbo Drive G2 512GB TLC SSD and 512GB TLC SED SSDCapacity or control Protocol512GB Capacity512GB C | | Performance | - | |
| HP Z Turbo Drive G2 Capacity 512GB 512GB 512GB TLC SSD and Protocol PCle Form Factor M.2 - Controller NVMe - NAND Type 3D TLC - SED Support 0pal 2 - Endurance 300TBW (TB Written) - Neator 1.5M hours - Interface PCI Express 3.0 x4 elettrus x4 physical Operating Temperature Sequential Read 300 MB/s* | | | • | |
| *Actual performance may-variable series of the series o | | | | |
| HP Z Turbo Drive G2 512GB TLC SSD and 512GB TLC SED SSDCapacity512GBProtocolPCleForm FactorM.2ControllerNVMeNAND Type3D TLCSED SupportOpal 2Endurance300TBW (TB Written)Reliability (MTBF)1.5M hoursInterfacePCI Express 3.0 x4 electrcal x4 physicalOperating Temperature2° to 158° F (0° to 70° C)PerformanceSequential Read3500 MB/s* | | | | 480K IOPS* |
| 512GB TLC SSD and 512GB TLC SED SSDProtocol Form FactorPCleForm FactorM.2ControllerNVMeNAND Type3D TLCSED SupportOpal 2Endurance300TBW (TB Written)Reliability (MTBF)1.5M hoursInterfacePCl Express 3.0 x4 electral x4 physicalOperating Temperature2° to 158° F (0° to 7)PerformanceSequential Read300 MB/s* | | *Actual performance may | vary. | |
| 512GB TLC SED SSDFrom FactorM.2Form FactorNVMeNVMeControllerNVMe3D TLCNAND Type3D TLCSED SupportSED Support0pal 2100 HWritten)Reliability (MTBF)1.5M hoursInterfacePCI Express 3.0 x4 electral x4 physicalOperating Temperature2° to 158° F (0° to 70° UPerformanceSequential Read3500 MB/s* | | | 512GB | |
| Form FactorM.2ControllerNVMeNAND Type3D TLCSED SupportOpal 2Endurance300TBW (TB Written)Reliability (MTBF)1.5M hoursInterfacePCI Express 3.0 x4 electrical x4 physicalOperating Temperature32° to 158° F (0° to 70° C)PerformanceSequential Read3500 MB/s* | | Protocol | PCle | |
| NAND Type3D TLCSED SupportOpal 2Endurance300TBW:ftten)Reliability (MTBF)1.5M hoursInterfacePCI Express 3.0 x4 electral x4 physicalOperating Temperature32° to 158° F (0° to 70° UPerformanceSequential Read | | | M.2 | |
| SED SupportOpal 2Endurance300TBW (TB Written)Reliability (MTBF)1.5M hoursInterfacePCI Express 3.0 x4 electrical x4 physicalOperating Temperature32° to 158° F (0° to 70° C)PerformanceSequential Read3500 MB/s* | | Controller | | |
| Endurance300TBW (TB Written)Reliability (MTBF)1.5M hoursInterfacePCI Express 3.0 x4 electrical x4 physicalOperating Temperature32° to 158° F (0° to 70° C)PerformanceSequential Read3500 MB/s* | | NAND Type | 3D TLC | |
| Reliability (MTBF)1.5M hoursInterfacePCI Express 3.0 x4 electrical x4 physicalOperating Temperature32° to 158° F (0° to 70° C)PerformanceSequential Read3500 MB/s* | | •• | • | |
| InterfacePCI Express 3.0 x4 electrical x4 physicalOperating Temperature32° to 158° F (0° to 70° C)PerformanceSequential Read3500 MB/s* | | | - |) |
| Operating Temperature 32° to 158° F (0° to 70° C) Performance Sequential Read 3500 MB/s* | | - | | |
| PerformanceSequential Read3500 MB/s* | | | • | |
| • | | | | |
| Sequential Write 2900 MB/s * | | Performance | - | |
| | | | Sequential Write | 2900 MB/s * |

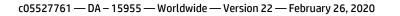


Random Read

460K IOPS*

HP Z6 G4 Workstation

| | | Random Write | 500K 10PS* |
|---|-------------------------|--------------------------|-------------------|
| | *Actual performance may | vary. | |
| HP Z Turbo Drive G2 | Capacity | 1TB | |
| 1TB TLC SSD and | Protocol | PCIe | |
| 1TB TLC SED SSD | Form Factor | M.2 | |
| | Controller | NVMe | |
| | NAND Type | 3D TLC | |
| | SED Support | Opal 2 | |
| | Endurance | 400TBW (TB Written) | |
| | Reliability (MTBF) | 1.5M hours | |
| | Interface | PCI Express 3.0 x4 elect | rical x4 physical |
| | Operating Temperature | 32° to 158° F (0° to 70° | C) |
| | Performance | Sequential Read | 3500 MB/s* |
| | | Sequential Write | 3000 MB/s * |
| | | Random Read | 580K IOPS* |
| | | Random Write | 500K IOPS* |
| | *Actual performance may | vary. | |
| HP Z Turbo Drive G2 | Capacity | 2TB | |
| 2TB TLC SSD and | Protocol | PCIe | |
| 2TB TLC SED SSD | Form Factor | M.2 | |
| | Controller | NVMe | |
| | NAND Type | 3D TLC | |
| | SED Support | Opal 2 | |
| | Endurance | 500TBW (TB Written) | |
| | Reliability (MTBF) | 1.5M hours | |
| | Interface | PCI Express 3.0 x4 elect | |
| | Operating Temperature | 32° to 158° F (0° to 70° | - |
| | Performance | Sequential Read | 3500 MB/s* |
| | | Sequential Write | 3000 MB/s * |
| | | Random Read | 600K IOPS* |
| | *Actual parformanco may | Random Write | 500K IOPS* |
| | *Actual performance may | - | |
| HP Z Turbo Drive Quad Pro 256GB SSD module | Capacity | 256GB (one M.2 PCIe NV | /Me module) |
| | Interface | PCI Express 3.0 x4 elect | rical x4 physical |
| | Operating Temperature | 32° to 158° F (0° to 70° | |
| HP Z Turbo Drive Quad Pro 512GB SSD module | Capacity | 512GB (one M.2 PCIe NV | /Me module) |
| | Interface | PCI Express 3.0 x4 elect | rical x4 physical |
| | Operating Temperature | 32° to 158° F (0° to 70° | C) |
| HP Z Turbo Drive Quad Pro 1TB SSD module | Capacity | 1TB (one M.2 PCIe NVM | e module) |
| | Interface | PCI Express 3.0 x4 elect | rical x4 physical |
| | Operating Temperature | 32° to 158° F (0° to 70° | C) |





| Fechnical Specificat | ions - Hard Drives | | | |
|--|---|--------------------------|--|----------------------|
| | HP Z Turbo Drive Quad Pro 2TB SSD module | Capacity | 2TB (one M.2 PCIe NV | 'Me module) |
| | | Interface | PCI Express 3.0 x4 ele | ectrical x4 physical |
| | | Operating Temperature | 32° to 158° F (0° to 7 | 0° C) |
| Intel® 905p Series AIC | Intel® 905p Series AIC | Capacity | 280GB | |
| PCIe SSD | 280GB PCIe SSD | Protocol | PCle | |
| | | Form Factor | PCIe Card, Half Heigh | t |
| | | Controller | NVMe | |
| | | NVM Туре | 3DXPoint | |
| | | Endurance | 5.11 PBW (PB Writter | ר) |
| | | Reliability (MTBF) | 1.6M hours | |
| | | Operating Temperature | 32° to 185° F (0° to 8 | 5° C) |
| | | Performance | Sequential Read | 2730 MB/s* |
| | | | Sequential Write | 2280 MB/s* |
| | | | Random Read | 587K IOPS* |
| | | | Random Write | 559K IOPS* |
| | | *Actual performance may | vary. | |
| Intel® 905p S 480GB PCIe S | Intel [®] 905p Series AIC | Capacity | 480GB | |
| | 480GB PCIe SSD | Protocol | PCIe | |
| | | Form Factor | PCIe Card, Half Heigh | t |
| | | Controller | NVMe | |
| | | NVM Туре | 3DXPoint | |
| | | Endurance | 8.76 PBW (PB Writter | ר) |
| | | Reliability (MTBF) | 1.6M hours | |
| | | Operating Temperature | 32° to 185° F (0° to 8 | 5° C) |
| | | Performance | Sequential Read | 2710 MB/s* |
| | | | Sequential Write | 2280 MB/s* |
| | | | Random Read | 582K IOPS* |
| | | *Actual performance may | Random Write vary. | 561K IOPS* |
| | | | | |
| Intel® Optane™ DC Persistent Memory | Intel® Optane™ DC Persistent Memory | Capacity | 128GB | |
| i ci sistent richiui y | 128GB Module | Protocol | DDR-T | |
| | | Form Factor | DDR4 | |
| | | Controller | NVMe | |
| | | NVM Type Endurance | 3DXPoint 292 PBW (256B Sequent 21 DBW (64B Sequent | |
| | | Reliability (MTBF) | 91 PBW (64B Sequen 2M hours | |
| | | NCUADILILY (MIDE) | | |
| | | Operating Temperature | 32° to 185° F (0° to 8 | 5° () |



Sequential Write 1850 MB/s*

*Actual performance may vary.



Technical Specifications - Hard Drive Controllers

HARD DRIVE CONTROLLERS

| Microsemi SmartHBA2100-4i4e SAS Controller | PCI Bus | 8 lanes, PCI Express 3.0 | |
|--|-----------------------------------|---------------------------------------|--------------------|
| | RAID Levels | Offers Integrated RAID (0, 1, and 10) | |
| | PCI Data Burst Transfer Rate | Half Duplex x8, PCIe, 8000 MB/s | |
| | SAS Bandwidth | Half Duplex | 1200 MB/s per lane |
| | PCI Card Type | 3.3V Add-in Card | |
| | PCI Voltage | 12 V ± 10% | |
| | PCI Power | 9.8W typical, Airflow min 200 LFM | |
| | Bracket | Full height and low profile | |
| | Certification Level | PCI Express 3.0 compliant | |
| | SAS Processor | Microsemi SmartIOC 2100 SAS IO Cont | troller |
| | Internal Connectors | One x4 internal mini-SASHD (SFF-864 | 43) |
| | External Connectors | One x4 external mini-SASHD (SFF-864 | 14) |
| | Maximum Number of SCSI Devices | 256 Non-RAID SAS/SATA devices | |
| | LED Indicators | Connector for Drive Activity Light | |

Technical Specifications - Graphics

GRAPHICS

| NVIDIA® Quadro® P400 2GB Graphics | Form Factor | Dimensions: 2.713" H x 5.7" L Single Slot, Low Profile Cooling: Active Weight: 129 grams |
|--------------------------------------|-------------------------------|---|
| | Graphics Controller | NVIDIA® Quadro® P400 Graphics Card GPU: 256 NVIDIA® CUDA® cores Max Power: 30 Watts |
| | Bus Type | PCI Express 3.0 x16 |
| | Memory | Size: 2 GB GDDR5, 2000 MHz Memory Interface: 64-bit Memory Bandwidth: 32 GB/s |
| | Connectors | 3mDP Outputs |
| | Maximum Resolution | DisplayPort™ 1.4: - up to 3x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST) |
| | Image Quality Features | 10-bit internal display processing pipeline 10-bit scan-out support |
| | Display Output | 3 mDP Connectors |
| | Shading Architecture | Full Microsoft DirectX [®] 12 Shader Model 5.1 |
| | Supported Graphics APIs | OpenGL [®] 4.5 DirectX [®] 12 Vulkan™ 1.0 API support includes: CUDA C, CUDA C++, DirectCompute , OpenCL™ |
| | Available Graphics Drivers | Microsoft Windows 10 Microsoft Windows 7 Professional 64-bit Linux® |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| | Notes | |
| NVIDIA® Quadro® P620 2GB Graphics | Form Factor | Dimensions: 2.713" H x 5.7" L Single Slot, Low Profile Cooling: Active Weight: 129 grams |
| | Graphics Controller | NVIDIA® Quadro® P620 Graphics Card GPU: 512 CUDA cores Max Power: 40 Watts |
| | Bus Type | PCI Express 3.0 x16 |
| | Memory | Size: 2 GB GDDR5, 2000 MHz Memory Interface: 128-bit Memory Bandwidth: 64 GB/s |



| | Connectors | 4mDP Outputs * |
|------------------------------------|-------------------------------|--|
| | Maximum Resolution | DisplayPort™ 1.4: |
| | | - up to 4x 5120 x 2880 x 24 bpp @ 60Hz |
| | | - supports Multi-Stream Transport (MST) |
| | Image Quality Features | 10-bit internal display processing pipeline 10-bit scan-out support |
| | Display Output | 4 mDP Connectors |
| | Shading Architecture | Full Microsoft DirectX 12 Shader Model 5.1 |
| | Supported Graphics APIs | OpenGL 4.5 DirectX 12 Vulkan 1.0 API support includes: |
| | | CUDA C, CUDA C++, DirectCompute , OpenCL |
| | Available Graphics Drivers | Windows10 (64-bit) Windows 7 Professional 64-bit |
| | DIIVEIS | |
| | | Linux® |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| | Notes | *P620 only have mini-DisplayPort™ (mDP) video ports. |
| | | Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included After market option kit:Two mDP-to-DP Adapters included |
| | | Additional mDP-to-DP Adapters are available as Factory Configuration or Option Kit accessories: - 2MY05AA - HP miniDP-to-DP Adapter Cables - 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables |
| AMD FirePro™ W2100 2GB Graphics | Form Factor | Low Profile, half length (full-height bracket included) |
| 2 ου σταμπες | Graphics Controller | AMD FirePro™ W2100 professional graphics based on Oland GPU. GPU: 320 Stream Processors organized into 5 Compute Units GPU Frequency: 630Mhz Power: 26W Cooling: Active |
| | Bus Type | PCI Express [®] x8, Generation 3.0 |
| | Memory | 2GB DDR3 memory Memory Bandwidth: up to 28.8 GB/s Memory Width: 128 bit |
| | Connectors | 2x Display Port™ 1.2 connectors |
| | | Factory Configured: No video cable adapter included After market option kit: No video cable adapter included |



| | | Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories. |
|---------------------------------------|-------------------------------|---|
| | Maximum Resolution | DisplayPort™ 1.2: - up to 4096x2160 x 24 bpp @ 60Hz |
| | | Dual Link DVI(I) (requires adapter cable): - up to 2560 x 1600 x 32 bpp @ 60Hz |
| | | Single Link-DVI(I)(requires adapter cable): - up to 1920 x 1200 x 32 bpp @ 60Hz |
| | | VGA (requires adapter cable): - up to 1920 x 1200 x 32 bpp @ 60Hz |
| | Image Quality Features | Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component. High bandwidth scaler for high quality up and downscaling. |
| | Display Output | 2 x DisplayPort™ 1.2a Maximum number of displays: 2 |
| | Shading Architecture | Shader Model 5.0 |
| | Supported Graphics APIs | OpenCL™ 1.2, DirectX [®] 11.2/12, OpenGL [®] 4.4 |
| | | OpenGL [®] 4.4 support with driver release 14.301.xxx OpenCL™ 1.2 conformance expected with drive release 14.301.xxx |
| | Available Graphics Drivers | Windows10 (64-bit) Windows 7 Professional 64-bit Linux® |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| | Notes | Depending on the card model, native DisplayPort [™] connectors and/or certified DisplayPort [™] active or passive adapters to convert your monitor's native input to your card's DisplayPort [™] or Mini-DisplayPort [™] connector(s) may be required. See www.amd.com/FirePro [™] for details. |
| NVIDIA® Quadro® P1000 4GB Graphics | Form Factor | Dimensions:2.713" H x 5.7" L Single Slot, Low Profile Cooling: Active Weight: 129 grams |
| | Graphics Controller | NVIDIA® Quadro® P1000 Graphics Card GPU: 640 NVIDIA® CUDA® cores |
| | Pue Tupe | Max Power: 47 Watts |
| | Bus Type Momory | PCI Express 3.0 x16 |
| | Memory | Size: 4 GB GDDR5, 2500 MHz Memory Interface: 128-bit memory interface |



| | | Memory Bandwidth: 80 GB/s memory bandwidth |
|---------------------------------------|-------------------------------|---|
| | Connectors | 4mDP Outputs |
| | Maximum Resolution | DisplayPort™ 1.4: |
| | Maximum Resolution | - up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST) |
| | Image Quality Features | 10-bit internal display processing pipeline 10-bit scan-out support |
| | Display Output | 4 mDP Connectors |
| | Shading Architecture | Full Microsoft DirectX [®] 12 Shader Model 5.1 |
| | Supported Graphics APIs | OpenGL [®] 4.5 DirectX [®] 12 Vulkan™ 1.0 API support includes: CUDA C, CUDA C++, DirectCompute , OpenCL™ |
| | Available Graphics Drivers | Microsoft Windows 10 Microsoft Windows 7 Professional 64-bit Linux® |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| | Notes | |
| NVIDIA® Quadro® P2000 5GB Graphics | Form Factor | Dimensions: 4.4"Hx7.9"L Single Slot Cooling: Active Weight: 260 grams |
| | Graphics Controller | NVIDIA® Quadro® P2000 Graphics Card Power: 75 Watts |
| | Bus Type | PCI Express 3.0 x16 |
| | Memory | Size: 5GB GDDR5 Memory Bandwidth: 140 GB/s Memory Width: 160-bit |
| | Connectors | 4x DisplayPort™ 1.4 |
| | | Factory Configured Option: No adapter included with card After Market Option: No video cable adapter included |
| | | Additional DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories. |
| | Maximum Resolution | DisplayPort™: - up to 5120 x 2880 x 24 bpp @ 60Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) DP 1.3 & 1.4 ready. |
| | | DL-DVI(I) output: - up to 2560 x 1600 x 32 bpp @ 60 Hz |
| | | Single Link-DVI(I) output: - up to 1920 x 1200 x 32 bpp @ 60Hz |



| | | HDMI 2.0 (requires DP to HDMI adapter): |
|---------------------------------------|---------------------------------|--|
| | | 5120 x 2880 x 24 bpp @ 60Hz |
| | Image Quality Features | 12-bit internal display pipeline (hardware support for 12-bit scanout on supported panels, applications and connection) |
| | | Stereoscopic 3D display support including NVIDIA® 3D Vision™ technology, NVIDIA® Mosaic and nView. |
| | Display Output | Maximum number of displays - 4 direct attached monitors |
| | | Maximum number of monitors across all available Quadro P2000 outputs is 4. |
| | Shading Architecture | Shader Model 5.1 |
| | Supported Graphics APIs | OpenGL [®] 4.5 |
| | | DirectX [®] 12 |
| | | API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran software |
| | Available Graphics | Microsoft Windows 10 |
| | Drivers | Microsoft Windows 7 Professional 64bit Linux [®] - Full OpenGL [®] implementation, complete with NVIDIA [®] and ARB extensions |
| | | HP qualified drivers may be preloaded or available from the HP support |
| | | Web site: |
| | Notes | http://welcome.hp.com/country/us/en/support.html |
| | | |
| NVIDIA® Quadro® P2200 5GB Graphics | Form Factor | Dimensions: 4.4"H x 7.9"L Single Slot, Full Height |
| | | |
| · | | Weight: 260 grams |
| | Graphics Controller | |
| • | Graphics Controller | Weight: 260 grams NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores |
| • | Graphics Controller | NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores Power: 75 Watts |
| | Graphics Controller | NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores |
| | Graphics Controller Bus Type | NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores Power: 75 Watts |
| | | NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores Power: 75 Watts Cooling: Active PCI Express 3.0 x16 Size: 5GB GDDR5X |
| | Bus Type | NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores Power: 75 Watts Cooling: Active PCI Express 3.0 x16 Size: 5GB GDDR5X Memory Bandwidth: 200 GB/s |
| | Bus Type | NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores Power: 75 Watts Cooling: Active PCI Express 3.0 x16 Size: 5GB GDDR5X |
| | Bus Type Memory | NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores Power: 75 Watts Cooling: Active PCI Express 3.0 x16 Size: 5GB GDDR5X Memory Bandwidth: 200 GB/s Memory Width: 160-bit |
| | Bus Type Memory | NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores Power: 75 Watts Cooling: Active PCI Express 3.0 x16 Size: 5GB GDDR5X Memory Bandwidth: 200 GB/s Memory Width: 160-bit 4x DisplayPort™ 1.4 Factory Configured Option: No adapter included with card |
| | Bus Type Memory | NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores Power: 75 Watts Cooling: Active PCI Express 3.0 x16 Size: 5GB GDDR5X Memory Bandwidth: 200 GB/s Memory Width: 160-bit 4x DisplayPort™ 1.4 Factory Configured Option: No adapter included with card After Market Option: No video cable adapter included Additional DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and |



| | | - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) DP 1.3 & 1.4 ready. |
|--------------------|-------------------------------|--|
| | | DL-DVI(I) output: - up to 2560 x 1600 x 32 bpp @ 60 Hz |
| | | Single Link-DVI(I) output: - up to 1920 x 1200 x 32 bpp @ 60Hz |
| | | HDMI 2.0 (requires DP to HDMI adapter): 5120 x 2880 x 24 bpp @ 60Hz |
| | Image Quality Features | 12-bit internal display pipeline (hardware support for 12-bit scanout on supported panels, applications and connection) |
| | | Stereoscopic 3D display support including NVIDIA® 3D Vision™ technology, NVIDIA® Mosaic and nView. |
| | Display Output | Maximum number of displays - 4 direct attached monitors |
| | | Maximum number of monitors across all available NVIDIA® Quadro® P2200 outputs is 4. |
| | Shading Architecture | Shader Model 5.1 |
| | Supported Graphics APIs | OpenGL [®] 4.5 DirectX [®] 12 |
| | | API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran software |
| | Available Graphics Drivers | Microsoft Windows 10 Microsoft Windows 7 Professional 64bit Linux® - Full OpenGL [®] implementation, complete with NVIDIA® Quadro [®] and ARB extensions |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: |
| | Notes | http://welcome.hp.com/country/us/en/support.html Quadro P2200 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately. Quadro P2200 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately. |
| AMD Radeon™ Pro WX | Form Factor | Low-Profile Single Slot (6.6" Length) |
| 3100 4GB Graphics | Graphics Controller | Polaris12 GL GPU: 512 Stream Processors organized into 8 Compute Units Power: 50 Watts Cooling: Active |
| | Memory | 4GB GDDR5 memory Memory Bandwidth: 6 Gbps / 96 GB/s Memory Width: 128 bit |



| | Connectors | 2x Mini DisplayPort™ 1.4 plus 1x DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support. |
|---|------------------------------------|--|
| | | Factory Configured: No adapters included After market option kit: One mDP-to-DP cable adapters included |
| | | Additional Mini DisplayPort™-to-DisplayPort™, DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories. |
| | Maximum Resolution | 5K support @ 60Hz • 1x single-cable 5K monitor, or 2x dual-cable 5K monitors 3x 4K support @ 60Hz |
| | Image Quality Features | Advanced support for 8-bit and 10-bit per RGB color component. High bandwidth scaler for high quality up and downscaling |
| | Display Output | 3 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support |
| | GPU Architecture | Polaris |
| | Supported Graphics APIs | DirectX°12 OpenGL° 4.5 OpenCL™ 2.0 Vulkan™ 1.0 |
| | Available Graphics Drivers | Windows 10 64-bit (Windows® 7 64-bit available from AMD) Linux® 64-bit (selected Enterprise distributions) |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| | Notes | HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro[™] and Radeon[™] Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions. As of September 2016, certified for DisplayPort[™] 1.4 HBR3 and ready for DisplayPort[™] 1.4 HDR based on independent verification by DisplayPort[™] testing authority. HDR content requires that the system be configured with a fully HDR- ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. |
| AMD Radeon™ Pro WX 3200 4GB Graphics | Form Factor Graphics Controller | Low-Profile Single Slot (2.75 "H x 6.6" L) Radeon™ Pro WX 3200 Graphics Card GPU: 640 Stream Processors organized into 8 Compute Units |



| Memory | Power: 56 Watts Cooling: Active 4GB GDDR5 memory Memory Bandwidth: 96 GB/s Memory Width: 128 bit | |
|-------------------------------|---|--|
| Connectors | 4x Mini DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support. | |
| | Factory Configured: No adapters included After market option kit: One mDP-to-DP cable adapters included | |
| | Additional Mini DisplayPort™-to-DisplayPort™, DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories. | |
| Maximum Resolution | 5K support @ 60Hz • 1x single-cable 5K monitor, or 2x dual-cable 5K monitors 4x 4K support @ 60Hz | |
| Image Quality Features | Advanced support for 8-bit and 10-bit per RGB color component. High bandwidth scaler for high quality up and downscaling | |
| Display Output | 4 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support | |
| GPU Architecture | Polaris | |
| Supported Graphics APIs | DirectX°12 OpenGL° 4.6 OpenCL™ 2.0 Vulkan™ 1.0 | |
| Available Graphics Drivers | Windows 10 64-bit Linux® 64-bit (selected Enterprise distributions) | |
| | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html | |
| Notes | HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro[™] and Radeon[™] Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions. As of September 2016, certified for DisplayPort[™] 1.4 HBR3 and ready for DisplayPort[™] 1.4 HDR based on independent verification by DisplayPort[™] testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. | |



| Radeon™ Pro WX 4100 | Form Factor | Low-Profile Single Slot (6.6" Length) |
|---------------------|-------------------------------|---|
| 4GB Graphics | Graphics Controller | Polaris 11 Baffin GL XT |
| | | GPU: 1024 Stream Processors organized into 16 Compute Units |
| | | Power: 50 Watts Cooling: Active |
| | Memory | 4GB GDDR5 memory |
| | Hemory | Memory Bandwidth: 6 Gbps / 96 GB/s |
| | | Memory Width: 128 bit |
| | Connectors | 4x Mini DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support. |
| | | Factory Configured: Four mDP-to-DP cable adapters included After market option kit: Four mDP-to-DP cable adapters included |
| | | Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories. |
| | Maximum Resolution | 5K support @ 60Hz |
| | | • 1x single-cable 5K monitor, or 2x dual-cable 5K monitors 4x 4K support @ 60Hz |
| | Image Quality Features | Advanced support for 8-bit and 10-bit per RGB color component. High bandwidth scaler for high quality up and downscaling |
| | Display Output | 4 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support |
| | GPU Architecture | GCN 4th Generation |
| | Supported Graphics APIs | |
| | | OpenGL [®] 4.5 |
| | | OpenCL™ 2.0 Vulkan™ 1.0 |
| | Ausilable Craphice | Windows 10 64-bit |
| | Available Graphics Drivers | Windows 10 64-bit Windows [®] 7 64-bit |
| | | Linux [®] 64-bit (selected Enterprise distributions) |
| | | HP qualified drivers may be preloaded or available from the HP support |
| | | Web site: http://welcome.hp.com/country/us/en/support.html |
| | Notes | HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating current curport |
| | | Windowed mode content requires operating system support. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro[™] and Radeon[™] Pro products, which are designed to intelligently manage GPU power consumption |
| | | in response to certain GPU load conditions. 9. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent |



| | | verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR- ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windows mode content requires operating system support. |
|---------------------------------------|------------------------|--|
| NVIDIA® Quadro® P4000 8GB Graphics | Form Factor | Dimensions: 4.4"H x 9.5"L Single-slot, full-height Weight: 475 grams (without extender) |
| | Graphics Controller | NVIDIA® Quadro® P4000 Graphics Card GPU: 1792 CUDA cores Power: 120 Watts |
| | Bus Type Memory | PCI Express 3.0 x16 Size: 8GB GDDR5 Memory Bandwidth: 243 GB/s Memory Width: 256-bit |
| | Connectors | 4 x DisplayPort 1.4 3-pin mini-DIN connector via optional bracket 1 x 6-pin auxiliary power connector 4-pin header for stereo signal SYNC connector for Quadro® Sync II 2 x SLI connectors |
| | | Factory Configured Option: No video cable adapter included After Market Option: No video cable adapter included Additional DisplayPort-to-VGA, DisplayPort-to-HDMI, or DisplayPort-to- DVI adapters are available as accessories |
| | Maximum Resolution | Dual-link internal TMDS (DVI 1.0): - up to 2560 x 1600 x 32 bpp @ 60 Hz |
| | | Single-link internal TMDS (DVI 1.0): - up to 1920 x 1200 x 32 bpp @ 60 Hz HDMI™ 2.0b (requires DP to HDMI adapter): - up to 5120 x 2880 x 24 bpp @ 60Hz |
| | | DisplayPort: - up to 4096 x 2160 x 30 bpp @ 60Hz - up to 2560 x 1600 x 30 bpp @ 120 Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) |
| | Image Quality Features | Using two DP outputs, the P4000 can drive one dual DP input display with 5120 x 2880 x 30 bpp @ 60Hz resolution. Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort, DVI, and HDMI connectors NVIDIA 3D Vision™ and other 3D stereo technologies NVIDIA Mosaic and nView |



| Display Output | Maximum number of displays - 4 direct attached monitors | |
|---|--|--|
| Shading Architecture Supported Graphics APIs | Maximum number of monitors across all available Quadro P4000 outputs is 4. Shader Model 5.1 GopenGL 4.5 DirectX 12 Vulcan 1.0 | |
| Available Graphics Drivers | API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran Microsoft Windows 10 Microsoft Windows 7 Linux - Full OpenGL implementation, complete with NVIDIA and ARB extensions | |
| Notes | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html 1. Quadro P4000 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately. 2. Quadro P4000 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately. | |

| NVIDIA® Quadro® GP100 16GB Graphics | Form Factor Graphics Controller | Dual Slot (4.4" Height x 10.5" Length) Weight: 989 grams +72 grams extender NVIDIA® QUADRO® GP100 GPU: 3584 NVIDIA CUDA® Parallel Processing Cores Power: 235 Watts Cooling: Active |
|--|------------------------------------|---|
| | Memory | 16GB HBM2 Memory Bandwidth: Up to 717 GB/s Memory Width: 4096-bit ECC Memory (disabled by default) |
| | Connectors | DP (x4) with HDR support DL-DVI(D) 3-pin mini-DIN connector via optional bracket 4-pin header for stereo signal Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector (2x) NVLink connectors |

Factory configured option: 8-pin power adapter included with card.



Technical Specifications - Graphics After market option Kit: 8-pin power adapter included with card. DVI to VGA, DisplayPort[™] to VGA, DisplayPort[™] to DVI, and DisplayPort[™] to Dual-Link DVI adapters available as accessories. Maximum Resolution 5K support @ 60Hz 1x single-cable 5K monitor, or 2x dual-cable 5K monitors **Image Quality Features** HDR support over DisplayPort[™] 1.4 (SMPTE 2084/2086, BT. 2020) (4K @ 60 Hz 10b/12b HEVC Decode, 4K @ 60 Hz 10b HEVC Encode) HDCP 2.2 support over DisplayPort[™], DVI, and HDMI connectors NVIDIA 3D Vision[™] technology NVIDIA Mosaic and nView Desktop Management **Display Outputs** 4x DP1.4 MST & HDR2 outputs (up to 5120 x 2880 @ 60Hz) 1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz) 1x Single-link DVI-D output (up to 1920 x 1200 @ 60 Hz) HDMI[™] 2.0b (up to 5120 x 2880 @ 60Hz)* *requires DP to HDMI adapter **GPU** Architecture NVIDIA Pascal[™] DirectX[®]12, OpenGL[®] 4.5, Vulkan[™] 1.0 **Supported Graphics** APIs Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran **Available Graphics** Windows[®] 10 Drivers Windows® 7 Professional 64-bit Linux® HP gualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included After market option kit: No adapters included

NVIDIA® Quadro® P5000 16GB Graphics

Form Factor

Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 815 grams / 1.80 lbs



| Graphics Controller | Quadro™ P5000 graphics GPU: 2560 NVIDIA® CUDA® Parallel Processing Cores Power: 180 Watts Cooling: Active |
|------------------------------|--|
| Memory | 16GB GDDR5X memory Memory Bandwidth: Up to 288 GB/s Memory Width: 256 bit ECC Memory (disabled by default) |
| Connectors | DP (x4) with HDR support DL-DVI(D) 3-pin mini-DIN connector SLI connector Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card. DVI to VGA, DisplayPort [™] to VGA, DisplayPort [™] to DVI, and DisplayPort [™] to Dual-Link DVI adapters available as accessories. |
| Maximum Resolution | 5K support @ 60Hz 1x single-cable 5K monitor, or 2x dual-cable 5K monitors |
| Image Quality Features | Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors NVIDIA 3D Vision™ and other 3D stereo technologies NVIDIA® Mosaic and nView Desktop Management |
| Display Outputs ¹ | 4x DP1.4 HDR outputs (up to 3840x2160 UHD @ 120Hz refresh, or up to 8K at 30Hz) 1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz and 1920x1200 @ 120 Hz) |
| GPU Architecture | NVIDIA® Pascal™ |
| Supported Graphics APIs | DirectX®12 , OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran |



Technical Specifications - Graphics Windows® 10 64-bit **Available Graphics** Windows[®] 7 64-bit Drivers Linux[®] 64-bit HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html 1- Supports up to a total of 4 displays Notes **NVIDIA®** Quadro® **Form Factor** Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 967 grams / 2.14 lbs P6000 24GB Graphics **Graphics Controller** NVIDIA[®] Quadro[®] P6000 graphics GPU: 3840 NVIDIA[®] CUDA[®] Parallel Processing Cores Power: 250 Watts **Cooling:** Active 24GB GDDR5X memory Memory Memory Bandwidth: Up to 432 GB/s Memory Width: 384 bit ECC Memory (disabled by default) Connectors DP (x4) with HDR support DL-DVI(D) 3-pin mini-DIN connector **SLI** connector Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card. DVI to VGA, DisplayPort[™] to VGA, DisplayPort[™] to DVI, and DisplayPort[™] to Dual-Link DVI adapters available as accessories. **Maximum Resolution** 5K support @ 60Hz 1x single-cable 5K monitor, or 2x dual-cable 5K monitors Image Quality Features Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort[™], DVI, and HDMI connectors NVIDIA[®] 3D Vision[™] and other 3D stereo technologies



| Technical Specifications - Graphics | | | |
|--|-------------------------------|---|--|
| | | NVIDIA® Mosaic and nView | |
| | Display Outputs ¹ | 4x DP1.4 HDR outputs (up to 3840x2160 UHD @ 120Hz refresh, or up to 8K at 30Hz) 1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz and 1920x1200 @ 120 Hz) | |
| | GPU Architecture | NVIDIA® Pascal™ | |
| | Supported Graphics APIs | DirectX®12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran | |
| | Available Graphics Drivers | Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit | |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: | |
| | Notes | http://welcome.hp.com/country/us/en/support.html1- Supports up to a total of 4 displays | |
| | | | |
| NVIDIA® Quadro® RTX 4000 8GB Graphics | Form Factor | Full-Height Single Slot (4.4" Height x 9.5" Length) Weight: 550 grams / 1.21 lbs | |
| | Graphics Controller | NVIDIA® Quadro® RTX 4000 Graphics GPU: 2304 NVIDIA® CUDA® Parallel Processing Cores Power: 160 Watts Cooling: Active | |
| | Memory | 8GB GDDR6 memory Memory Bandwidth: Up to 416 GB/s Memory Width: 384 bit | |
| | Connectors | 3x DP 1.4a and VirtualLink Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector | |
| | | Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card. | |
| | | DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories. | |



| Technical Specifications - Graphics | | |
|---|-------------------------------|---|
| | Maximum Resolution | 7680x4320 @ 60Hz |
| | Image Quality Features | Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort [™] , DVI, and HDMI connectors NVIDIA [®] 3D Vision [™] and other 3D stereo technologies NVIDIA [®] Mosaic and nView |
| | Display Outputs ¹ | 3x DP 1.4a and VirtualLink (7680x4320 @ 60Hz) |
| | Supported Graphics APIs | DirectX [®] 12, OpenGL [®] 4.5, OpenCL [™] 1.0, Vulkan [™] 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL [™] , Java, Python, and Fortran |
| | Available Graphics Drivers | Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| | Notes | 1- Supports up to a total of 4 displays |
| NVIDIA® Quadro® RTX 5000 16GB Graphics | Form Factor | Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 1050 grams / 2.31 lbs |
| | Graphics Controller | NVIDIA® Quadro® RTX 5000 Graphics GPU: 3072 NVIDIA® CUDA® Parallel Processing Cores Power: 265 Watts Cooling: Active |
| | Memory | 16GB GDDR6 memory Memory Bandwidth: Up to 448 GB/s Memory Width: 384 bit |
| | Connectors | 4x DP 1.4a and VirtualLink Quadro Sync connector (compatible with Quadro II Sync) One 8-pin + 6-pin auxiliary power connector |
| | | Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card. |
| | | DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories. |



| | Maximum Resolution | 7680x4320 @ 60Hz |
|---|-------------------------------|---|
| | Image Quality Features | Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort [™] , DVI, and HDMI connectors NVIDIA [®] 3D Vision [™] and other 3D stereo technologies NVIDIA [®] Mosaic and nView |
| | Display Outputs ¹ | 4x DP 1.4a and VirtualLink (7680x4320 @ 60Hz) |
| | Supported Graphics APIs | DirectX®12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran |
| | Available Graphics Drivers | Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| | Notes | 1- Supports up to a total of 4 displays |
| NVIDIA® Quadro® RTX 6000 24GB Graphics | Form Factor | Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 1070 grams / 2.35 lbs |
| | Graphics Controller | NVIDIA® Quadro® RTX 6000 Graphics GPU: 4608 NVIDIA® CUDA® Parallel Processing Cores Power: 295 Watts Cooling: Active |
| | Memory | 24GB GDDR6 memory Memory Bandwidth: Up to 672 GB/s Memory Width: 384 bit |



| | Connectors | 4x DP 1.4a and VirtualLink Quadro Sync connector (compatible with Quadro II Sync) One 8-pin + 6-pin auxiliary power connector |
|---|-------------------------------|---|
| | | Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card. |
| | | |
| | | DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories. |
| | Maximum Resolution | 7680x4320 @ 60Hz |
| | Image Quality Features | Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. |
| | | HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors |
| | | NVIDIA [®] 3D Vision [™] and other 3D stereo technologies NVIDIA [®] Mosaic and nView |
| | Display Outputs ¹ | 4x DP 1.4a and VirtualLink (7680x4320 @ 60Hz) |
| | Supported Graphics APIs | DirectX®12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran |
| | Available Graphics Drivers | Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: |
| | Notos | http://welcome.hp.com/country/us/en/support.html |
| | Notes | 1- Supports up to a total of 4 displays |
| NVIDIA® Quadro® RTX 8000 48GB Graphics | Form Factor | Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 1070 grams / 2.35 lbs |
| | Graphics Controller | NVIDIA® Quadro® RTX 8000 Graphics GPU: 4608 NVIDIA® CUDA® Parallel Processing Cores Power: 295 Watts Cooling: Active |
| | Memory | 48GB GDDR6 memory Memory Bandwidth: Up to 672 GB/s Memory Width: 384 bit |



| | Connectors | 4x DP 1.4a and VirtualLink Quadro Sync connector (compatible with Quadro II Sync) One 8-pin + 6-pin auxiliary power connector |
|---------------------|-------------------------------|--|
| | | Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card. |
| | | DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories. |
| | Maximum Resolution | 7680x4320 @ 60Hz |
| | Image Quality Features | Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors NVIDIA® 3D Vision™ and other 3D stereo technologies NVIDIA® Mosaic and nView |
| | Display Outputs ¹ | 4x DP 1.4a and VirtualLink (7680x4320 @ 60Hz) |
| | Supported Graphics APIs | DirectX®12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran |
| | Available Graphics Drivers | Windows® 10 64-bit Linux® 64-bit |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| | Notes | Supports up to a total of 4 displays VirtualLink's USB-C[™] (data) cannot be disabled at a hardware level |
| Radeon™ Pro WX 7100 | Form Factor | Full-Height Single Slot (9.5" Length) |
| 8GB Graphics | Graphics Controller | Radeon™ Pro WX 7100 graphics GPU: 2304 Stream Processors organized into 36 Compute Units Power: 130 Watts Cooling: Active |
| | Memory | 8GB GDDR5 memory Memory Bandwidth: 7 Gbps / 224 GB/s Memory Width: 256 bit |
| | Connectors | 4x DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support. |
| | | Factory Configured: No video cable adapter included After market option kit: No video cable adapter included |



| | Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories. |
|-------------------------------|---|
| Maximum Resolution | 5K support @ 60Hz |
| | • 1x single-cable 5K monitor, or 2x dual-cable 5K monitors |
| Image Quality Features | Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component. High bandwidth scaler for high quality up and downscaling |
| Display Output | 4 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support |
| GPU Architecture | GCN 4th Generation |
| Supported Graphics APIs | DirectX [®] 12 OpenGL [®] 4.5 OpenCL™ 2.0 Vulkan™ 1.0 |
| Available Graphics Drivers | Windows 10 64-bit Windows® 7 64-bit Linux® 64-bit |
| | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| Notes | 10. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. 11. Radeon VR Ready Creator Products are select Radeon Pro and AMD FirePro™ GPUs that meet or exceed the Oculus Rift or HTC Vive recommended specifications for video cards/GPUs. Other hardware (including CPU) and system requirements recommended by Oculus Rift or HTC Vive should also be met in order to operate the applicable HMDs as intended. As VR technology, HMDs and other VR hardware and software evolve and/or become available, these criteria may change without notice. 12. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions. 13. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. |



| AMD Radeon™ Pro WX 9100 16GB Graphics | Form Factor | Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 1100 grams / 2.42 lbs |
|--|-------------------------------|---|
| | Graphics Controller | AMD Radeon™ Pro WX 9100 Vega architecture GPU GPU: 4096 NVIDIA® CUDA® Parallel Processing Cores Power: 250 Watts Cooling: Active |
| | Memory | 16GB HBM2 memory Memory Bandwidth: Up to 483 GB/s Memory Width: 384 bit |
| | Connectors | 6x mDP 1.4 Quadro Sync connector (compatible with Quadro II Sync) One 8-pin + 6-pin auxiliary power connector |
| | | Factory configured option: No video cable adapter included with card. After market option Kit: 2x mini-DP to DP. |
| | | DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories. |
| | Maximum Resolution | 7680 × 4320 resolution @ 60Hz 6x DP 1.3 4K @60Hz or 3x 5K @60Hz or 1x 8K @60Hz |
| | Image Quality Features | Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort [™] , DVI, and HDMI connectors NVIDIA [®] 3D Vision [™] and other 3D stereo technologies NVIDIA [®] Mosaic and nView |
| | Display Outputs ¹ | 6x mDP 1.4 (7680x4320 @ 60Hz) |
| | Supported Graphics APIs | DirectX®12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran |
| | Available Graphics Drivers | Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit |



| | | HP qualified drivers may be preloaded or available from the HP support Web site: |
|-------------------------|----------------------------------|---|
| | | http://welcome.hp.com/country/us/en/support.html |
| | Notes | 1- Supports up to a total of 6 displays |
| NVIDIA® Quadro® Sync II | Part number | 1WT20AA |
| | Dimensions (HxD) | 6.0 inches × 4.2 inches |
| | Devices Supported | NVIDIA® Quadro® P4000 NVIDIA® Quadro® P5000 NVIDIA® Quadro® P6000 |
| | Bus Type | Requires one free mechanical PCIe bus slot. 6-pin PCI or SATA power connector |
| | PCI Form Factor | Full Height, half length, single slot |
| | Ports | 2 RJ45 connectors for carrying frame lock signals over CAT5 cables. BNC Connector for external house synchronization. |
| | Internal Connectors | 6 NVIDIA SLI® style edge fingers for connection to compatible GPUs Included with the board are 4 12-Inch Short Sync Cables to connect to GPU's Included with the board are 2 24-Inch Long Sync Cables to connect to GPU's |
| | System Requirements | Requires one free mechanical PCIe bus slot. 6-pin PCI or SATA power connector Must be used with NVIDIA Quadro P4000, P5000 or P6000 graphics cards. Requires Quadro driver version R375 or later. |
| | Temperature - Operating | 0° to 55° C |
| | Temperature - Storage | -40° to 60° C |
| | Relative Humidity - Operating | 10% to 80% |
| | Power Requirements | Board power dissipation: <15W |
| | Operating Systems Supported | Windows 10 64-bit Windows 7 64-bit Linux® 64-bit |
| | Kit Contents | Contains: • Quadro Sync II Card • 4 x 12-Inch Short Sync Cables • 2 x 24-Inch Long Sync Cables (Two) • Quick Start Guide |

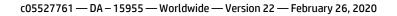


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Technical Specifications – Optical and Removable Storage

OPTICAL AND REMOVABLE STORAGE

| HP 9.5mm Slim DVD Writer | Description Mounting Orientation Interface Type Dimensions (WxHxD) Supported Media Types | 9.5mm height, tray-load Either horizontal or vertical SATA/ATAPI 128 x 9.5 x 127mm DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW | |
|--------------------------------|--|--|---|
| | Disc Capacity | DVD-ROM | 8.5 GB DL or 4.7 GB standard |
| | | Full Stroke DVD | < 200 ms (seek) |
| | | Full Stroke CD | < 200 ms (seek) |
| | Maximum Data Transfer Rates | CD ROM Read | CD-ROM, CD-R Up to 24X CD-RW Up to 24X |
| | | DVD ROM Read | DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X |
| | Power | Source | SATA DC power receptacle |
| | | DC Power Requirements | 5 VDC ± 5%-100 mV ripple p-p |
| | | DC Current | 5 VDC -< 800 mA typical, <1600 mA maximum |
| | Operating Environmental | Temperature | 41° to 122° F (5° to 50° C) |
| | (all conditions non- | Relative Humidity | 10% to 80% |
| | condensing) | Maximum Wet Bulb Temperature | 84° F (29° C) |
| | Operating Systems Supported | Windows 10, Windows 7 Profession Red Hat® Enterprise Linux®(RHEL) V SUSE Linux® Enterprise Desktop 10 | WS4**, 5, 6 Desktop/Workstation |
| | | * No driver is required for this device. Native support is provided by the operating system. | |
| | Kit Contents | HP SATA DVD Writer drive, installat | ion guide. |
| HP 9.5mm Slim DVD-ROM Drive | Description Mounting Orientation Interface Type | 9.5mm height, tray-load Either horizontal or vertical SATA / ATAPI | |



| | Dimensions (WxHxD) Disc Capacity | 128 x 9.5 x 127mm DVD-ROM | Single layer: Up to 4.7 GB Double layer: Up to 8.5 GB |
|---|--|--|---|
| | Access Times | DVD-ROM Single Layer CD-ROM Mode 1 Full Stroke DVD | < 110 ms (typical) < 110 ms (typical) < 230 ms (typical) |
| | Power | Full Stroke CD Source DC Power Requirements DC Current | < 220 ms (typical) SATA DC power receptacle 5 VDC ± 5%-100 mV ripple p-p 5 VDC – <800mA typical, < 1600 mA |
| Operating Environmental (all conditions non- condensing) Operating Systems | Temperature Relative Humidity Maximum Wet Bulb Temperature Windows 10, Windows 7 Profession | maximum 41° to 122° F (5° to 50° C) 10% to 80% 84° F (29° C) nal 64-bit | |
| | Supported | Red Hat [®] Enterprise Linux [®] (RHEL) SUSE Linux [®] Enterprise Desktop 10 No driver is required for this device operating system. | WS4**, 5, 6 Desktop/Workstation) & 11 |
| | Kit Contents | 9.5mm Slim DVD-ROM Drive, 5.25" data/power cable, installation guid | ODD Bay adapter/carrier, slim SATA le |
| | | | |
| HP HH DVD Writer (16X | Description | HP Half Height DVD Writer | |
| RW DVD-R) | Mounting Orientation | Either Horizontal or vertical | |
| | Interface Type | SATA | |
| | Dimensions (WxHxD) | 146x42x165mm | |
| | Supported Media Types | DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW | |
| | Disc Capacity | DVD-ROM | 8.5 GB DL or 4.7 GB standard |
| | | Full Stroke DVD | 145ms (seek) |
| | | Full Stroke CD | 120ms (seek) |
| | Maximum Data Transfer Rates | CD ROM Read | CD-ROM, CD-R Up to 24X CD-RW Up to 24X |
| | | DVD ROM Read | DVD+RW Up to 13X DVD-RW Up to 13X DVD+R DL Up to 12X DVD-R DL Up to 12X DVD-ROM Up to 12X DVD-ROM DL Up to 12X |



| | Power Operating Environmental (all conditions non- condensing) Operating Systems Supported | Source DC Power Requirements DC Current Temperature Relative Humidity Windows 10, Windows 7 Profession WS4**,5,6 Desktop/Workstation. No driver is required for this device, operating system. | |
|---------------------------------------|---|--|--|
| | Kit Contents | HP SATA DVD Writer drive, Installat | ion guide. |
| HP 9.5mm Slim BDXL Blu- Ray Writer | Description Mounting Orientation Interface Type Dimensions (WxHxD) Supported Media Types | 9.5mm height, tray-load Either horizontal or vertical SATA/ATAPI 128 x 9.5 x 127mm BD-ROM | |
| | | BD-R BD-RE DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW | |
| | Disc Capacity | DVD-ROM Blu-ray | 8.5 GB DL or 4.7 GB standard 25 GB (single-layer) 50 GB (dual-layer) 100/128 GB (BDXL) |
| | | Full Stroke DVD | < 230 ms (seek) |
| | | Full Stroke CD | < 220 ms (seek) |
| | | Blu-ray | < 230 ms (seek) (Full Stroke Blu-ray) |
| | | Startup Time | (Time to drive ready from tray loading) BD-ROM (SL/DL) 25S / 28S BD-R (SL/DL) 25S / 28S BD-RE (SL/DL) 25S / 28S DVD-ROM (SL/DL) 18S / 18S DVD-R (SL/DL) 25S / 25S DVD-RW 25S DVD-RW 25S DVD+R (SL/DL) 25S / 25S DVD+RW 25S |



| | | | CD-ROM 15S | |
|-------------------|---|--|--|--|
| | Maximum Data Transfer Rates | CD ROM Read | CD-ROM, CD-R Up to 24X CD-RW Up to 24X | |
| | | DVD ROM Read | DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X | |
| | | Blu-ray | BD-ROM Up to 6X BD-ROM DL Up to 6X BD-R Up to 6X BD-R DL Up to 6X BD-R Up to 6X BD-RE SL/DL Up to 6X | |
| | Power | Source | SATA DC power receptacle | |
| | | DC Power Requirements | 5 VDC ± 5%-100 mV ripple p-p | |
| | Operating Environmental (all conditions non- | DC Current | 5 VDC -900 mA typical, 2000mA maximum | |
| | | l Temperature | 41° to 122° F (5° to 50° C) | |
| | | Relative Humidity | 10% to 80% | |
| | condensing) | Maximum Wet Bulb Temperature | 84° F (29° C) | |
| | Operating Systems Supported | Windows 10, Windows 7 Professional 64-bit Red Hat® Enterprise Linux® (RHEL) 6, 7 Desktop/Workstation SUSE Linux® Enterprise Desktop 12 | | |
| Kit Contents | | No driver is required for this device. Native support is provided by the operating system. | | |
| | Kit Contents | 9.5mm Slim BDXL Blu-Ray Writer, 5 SATA data/power cable, installatio | 5.25" ODD Bay adapter/carrier, slim n guide | |
| | | As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation. | | |
| HP SD Card Reader | Description | Supports hardware ECC (Error Correction Code) function Supports hardware CRC (Cyclic Redundancy Check) function Supports SD 4-bit parallel transfer mode | | |
| | Interface Type | USB 3.1 GEN 1 High-speed interfac | | |
| | Dimensions (WxHxD) | | 15 mm) Fits conveniently in the Front IO | |
| | Supported Media Types | Secure Digital Card (SD) Secure Digital High Capacity (SDHC SD Extended Capacity Memory Card | | |



| | SD Ultra High Speed II(SD UHSII) |
|--------------------------------|--|
| | These additional media types are supported with a card adapter. Memory Stick Micro (M2) miniSD miniSD High Capacity Micro SD Memory Card (MicroSD) Micro SD High Capacity Memory Card (MicroSDHC) |
| | Test Parameters/Conditions - Power applied, unit operating on system ±5% |
| Operating Systems Supported | Windows 10 |
| | No driver is required for this device. Native support is provided by the operating system. |
| Kit Contents | Media card reader |
| Approvals | USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport Specification Rev. 1.0, |
| | Compliant Intel® Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE, BSMI, C-Tick, VCCI, MIC, cUL, TUVT |
| Weight | 0.35 lbs. (0.16 kg) |



Technical Specifications - Controller Cards

CONTROLLER CARDS

| HP Thunderbolt-3 Dual Port2 PCIe 1-port I/O | Data Transfer Rate Devices Supported | Supports up to 40 Gb/s (40,000 Mb/s) Thunderbolt™, Thunderbolt™ 2 and Thunderbolt™ 3 certified for Windows |
|--|---|---|
| Card | | devices |
| | Bus Type | PCIe card, full height PCIe slots |
| | Ports | Two Thunderbolt™ 3 external USB type-C output connectors (Rear) Two full size DisplayPort input connectors (Rear) |
| | Internal Connectors | One 2x5-Pin header connector |
| | System Requirements | Windows 10 Professional 64-bit, available dedicated PCH PCIe slot. |
| | Temperature - Operating | 50° to 131° F (10° to 55° C) |
| | Temperature - Storage | -22° to 140° F (-30° to 60° C) |
| | Relative Humidity - Operating | 20% to 80% |
| | Compliances | FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD, Taiwan BSMI CNS13438, Korea MIC |
| | Operating Systems Supported | Windows 10 Professional 64-bit. |
| | Kit Contents | HP Thunderbolt™ 3 Dual Port PCIe I/O Card, 2- DisplayPort cables, GPIO (General-Purpose Input/Output) cables, Installation documentation and warranty card. |

*Maximum speed requires DisplayPort[™] and PCIe aggregation.

NETWORKING AND COMMUNICATIONS

| Integrated Intel® I219LM | Connector | RJ-45 |
|--------------------------|----------------------|---|
| | Controller | Intel [®] I219LM |
| | Data Rates Supported | 10/100/1000 Mbps |
| | Boot ROM Support | PXE, UEFI |
| | Connect Speed LED | Link/Activity LED |
| | Indicators | • Off = No link |
| | | Blinking = Activity |
| | | Speed LED |
| | | Off = 10Mbps |
| | | Amber = 100Mbps |
| | | Green = 1000Mbps |

Management Capabilities Intel[®] Active Management Technology™ 11

| Integrated Intel® V722 | Connector | 1 RJ-45 |
|------------------------------------|---------------------------------------|---|
| Integrated Intel® X722 for 1GbE | Controller | Intel® X722 for 1GbE |
| | Data Rates Supported | 1000 Mbps |
| | Boot ROM Support | PXE, UEFI |
| | | |
| | Connect Speed LED Indicators | Link/Activity LED • Off = No link |
| | marcators | Blinking = Activity |
| | | Speed LED |
| | | • Off = No Link |
| | | • Green = 1000Mbps |
| | Management Capabilities | s Wake-On-LAN |
| HP Z Dual 10GbE Network | Networking Interface | 2 RJ-45 |
| Module | System Interface | Cabled from Dedicated Rear I/O Slot |
| | Networking Speeds Supported | 1Gbps, 10Gbps |
| | Cabling (up to 100m) | Cat5e (or higher) for 1Gbps Cat6a (or higher) for 10Gbps |
| | Power Consumption (active-typical) | 5.5W at 1Gbps 11.2W at 10Gbps |
| | Physical Dimensions | 0.875 in x 3 in x 2.75 in |
| | Connect Speed LED | Link/Activity LED |
| | Indicators | • Off = No link |
| | | Blinking = Activity |
| | | Speed LED |
| | | Amber = 1Gbps Green = 10Gbps |
| | Operating Temperature | |

Intel® I210-T1



| | System Interface | PCI Express 2.1 x1 |
|----------------|--|---|
| | Networking Speeds Supported | 10Mbps, 100Mbps, 1Gbps |
| | Cabling (up to 100m) | Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps |
| | Power Consumption (active-typical) | 0.81W |
| | Physical Dimensions | Length: 6.7cm (2.64 inches) (Bracket) Width: 1.8cm (0.709 inches) Full-height end bracket: 12.07cm (4.755 inches) Low-profile end bracket: 8cm (3.15 inches) |
| | Connect Speed LED Indicators | Link/Activity LED • Off = No link • Blinking = Activity Speed LED • Off = 10Mbps • Green = 100Mbps • Amber = 1Gbps |
| | Operating Temperature | 0 °C to 55 °C (32 °F to 131 °F) |
| | Hardware Certifications | USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003 |
| Intel® I350-T2 | Networking Interface | 2 RJ-45 |
| | System Interface | PCI Express 2.1 x4 |
| | Networking Speeds Supported | 10Mbps, 100Mbps, 1Gbps |
| | Cabling (up to 100m) | Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps |
| | Power Consumption (active-typical) | 4.4W |
| | Physical Dimensions | Length: 13.54cm (5.33 inches) Width: 6.89 (2.71 inches) Full-height end bracket: 12.0cm (4.725 inches) Low-profile end bracket: 7.92cm (3.117 inches) |
| | Connect Speed LED Indicators Operating Temperature | Link/Activity LED • Off = No link • Blinking = Activity Speed LED • Off = 10Mbps • Green = 100Mbps • Amber = 1Gbps 0 °C to 55 °C (32 °F to 131 °F) |
| | operating reinperature | |



| | | Communications | |
|-------------------|---------------------------------------|--|--|
| | Hardware Certifications | USA: FCC B, | |
| | | EU: UL CE, | |
| | | Japan: VCCI, Taiwan: BSMI | |
| | | Taiwan: BSMI, Australia/New Zealand: CTICK, | |
| | | Korea: KCC, | |
| | | Canada: ICES-003/NMB-003 | |
| Intel® 1350-T4 | Networking Interface | 4 RJ-45 | |
| | System Interface | PCI Express 2.1 x4 | |
| | - | • | |
| | Networking Speeds Supported | 10Mbps, 100Mbps, 1Gbps | |
| | Cabling (up to 100m) | Cat3 (or higher) for 10Mbps | |
| | | Cat5 (or higher) for 100Mbps | |
| | | Cat5e (or higher) for 1Gbps | |
| | Power Consumption (active-typical) | 5W | |
| | Physical Dimensions | Length: 13.54cm (5.33 inches) | |
| | | Width: 6.89 (2.71 inches) | |
| | | Full-height end bracket: 12.0cm (4.725 inches) Low-profile end bracket: 7.92cm (3.117 inches) | |
| | Connect Speed LED | Link/Activity LED | |
| | Indicators | • Off = No link | |
| | | • Blinking = Activity | |
| | | Speed LED | |
| | | • Off = 10Mbps | |
| | | Green = 100Mbps | |
| | | • Amber = 1Gbps | |
| | Operating Temperature | 0 °C to 55 °C (32 °F to 131 °F) | |
| | Hardware Certifications | USA: FCC B, | |
| | | EU: UL CE, Japan: VCCI, | |
| | | Taiwan: BSMI, | |
| | | Australia/New Zealand: CTICK, | |
| | | Korea: KCC, | |
| | | Canada: ICES-003/NMB-003 | |
| Aquantia® AQN-108 | Networking Interface | RJ-45 | |
| • | System Interface | PCI Express 3 x1 | |
| | Networking Speeds | 100Mbps, 1Gbps, 2.5Gbps, 5Gbps | |
| | Supported | 1001.0003, 10003, 2.30003 | |
| | Cabling (up to 100m) | Cat5e (or higher) for all speeds | |
| | Power Consumption (active-typical) | 3.5W at 5Gbps, 3.0W at 2.5Gbps | |
| | Physical Dimensions | 3.72 in x 3.18 in (without bracket) | |



| | Connect Speed LED Indicators Operating Temperature Hardware Certifications | Link/Activity LED • Off = No link • Blinking = Activity Speed LED • Off = No link • Amber = <5Gbps • Green = 5Gbps | |
|-----------------|---|---|--|
| | | 0°C to 55°C (32°F to 131°F) USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003 | |
| Intel® X550-T2 | Networking Interface | 2 x RJ-45 | |
| | System Interface | PCI Express 3 x4 | |
| | Networking Speeds Supported | 100Mbps, 1Gbps, 2.5Gbps, 5Gbps, 10Gbps | |
| | Cabling (up to 100m) | Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps, 2.5Gbps, or 5Gbps Cat6a (or higher) for 10Gbps | |
| | Power Consumption (active-typical) | 3.9W at 100Mbps 5.5W at 1Gbps 11.2W at 10Gbps | |
| | Physical Dimensions | 5.2 in x 2.7 in (without bracket) | |
| | Connect Speed LED Indicators | Link/Activity LED • Off = No link • Blinking = Activity Speed LED • Off = No link • Amber = <10Gbps • Green = 10Gbps | |
| | Operating Temperature | 0 °C to 55 °C (32 °F to 131 °F) | |
| | Hardware Certifications | USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003 | |
| Intel® X710-DA2 | Networking Interface | 2 SFP+ Ports for LC SFP+ Transceivers | |

Intel® X710-DA2 10GBASE-SR Converged Network Adapter

Networking Interface System Interface Networking Speeds Supported 2 SFP+ Ports for LC SFP+ Transceivers PCI Express 3.0 x8 1Gbps, 10Gbps



System Interface

Antenna

| | 6.1 P | | | |
|------------------|---------------------------------------|---|--|--|
| | Cabling Down Communities | LC fiber optic cabling with LC SFP+ Transceivers | | |
| | Power Consumption (active-typical) | 4.3W | | |
| | Physical Dimensions | 6.578 in x 2.703 in | | |
| | Connect Speed LED Indicators | Link/Activity LED • Off = No link • Blinking = Activity Speed LED • Off = 10Mbps • Green = 100Mbps • Amber = 1Gbps | | |
| | Operating Temperature | 0 °C to 55 °C (32 °F to 131 °F) | | |
| | Hardware Certifications | USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003 | | |
| | Note: Windows 7 is NOT supported | | | |
| 10GbE SFP+ SR | Connector Type | LC | | |
| Transceiver | Cable Type | 62.5/125um or 50/125um (core/cladding), graded-index, low metal content, multimode fiber optic, complying with ITU-T G.651 and ISO/IEC 793-2 Type A1b or A1a, respectively. | | |
| | Cable Length | 2-300m | | |
| | Wavelength | 850nm | | |
| | Form Factor | SFP+ | | |
| | Physical Dimensions | 0.47(h) x 0.54(w) x 2.19(d) inches (1.19 x 1.38 x 5.57 cm) | | |
| | Operating Temperature | OC to 45C (32F to 113F) | | |
| | Operating Humidity | 0% to 85%, noncondensing | | |
| Intel® 8265 WLAN | Networking Speeds | 802.11ac MU-MIMO (up to 867 Mbps) Bluetooth 4.2 | | |
| | IEEE WLAN Standard | IEEE 802.11a/b/g/n/ac, 802.11d, 802.11e, 802.11h, 802.11i, 802.11w; 802.11r, 802.11k, 802.11v pending | | |
| | | 002.111, 002.11X, 002.11V pending | | |



PCI Express 2.1 x1

2x2

Summary of Changes

SUMMARY OF CHANGES

| Date of change: | Version History: | | Description of change: |
|--------------------|------------------|---------|--|
| November 1, 2017 | From v1 to v2 | Added | HP DisplayPort to HDMI Adapter, HP DisplayPort to VGA Adapter, NVIDIA SLI 3-slot Graphics Connector and NVIDIA Quadro Sync II to Graphics section and Microsemi 3152-8i SAS ROC RAID Controller |
| | | Changed | Graphics, Storage / Hard Drives and Memory sections, changed Front and internal view info on the Overview section, changed Operating Systems section, changed System Board section, Physical Security and Serviceability sections |
| November 29, 2017 | From v2 to v3 | Added | Processors, hard drives and graphics to offerings, added Declared Noise Emissions information |
| January 30, 2018 | From v3 to v4 | Removed | NVIDIA SLI Graphics Connectors from Graphics Cable Adapters section |
| March 27, 2018 | From v4 to v5 | Added | Intel Xeon processors added |
| April 16, 2018 | From v5 to v6 | Removed | RAID 5 |
| August 13, 2018 | From v6 to v7 | Added | Footnote to Networking and Communications section |
| | | Changed | Processors section and Operating Systems section |
| September 4, 2018 | From v7 to v8 | Removed | HP IEEE 1394b FireWire PCIe Card |
| September 6, 2018 | From v8 to v9 | Removed | Microsemi 3152-8i SAS ROC RAID Controller |
| September 21, 2018 | From v9 to v10 | Added | Intel Optane SSD 905p AiC 280GB & 480GB |
| September 26, 2018 | From v10 to v11 | Changed | NVIDIA Quadro P6000 Graphics specs |
| April 8, 2019 | From v11 to v12 | Added | New Intel Xeon Processors and graphics, added HP DX175 Removable HDD Carrier into the HDD Frame/Carriers section |
| | | Changed | Storage / Hard Drives, Memory sections and format changes |
| May 15, 2019 | From v12 to v13 | Added | NVIDIA Quadro RTX 8000 48GB Graphics |
| | | Changed | External BIOS simulator link on Physical Security and Serviceability section |
| | | Removed | Intel 9260 WLAN |
| June 12, 2019 | From v13 to v14 | Changed | Storage section |
| July 7, 2019 | From v14 to v15 | Added | Intel Xeon W Processors |
| July 15, 2019 | From v15 to v16 | Changed | Corrected Intel 905p Series AIC 480GB PCIe SSD |
| August 1, 2019 | From v16 to v17 | Changed | Processors Matrix |
| September 1, 2019 | From v17 to v18 | Added | Footnote to Memory section, Added Optane 905P 380GB M.2 SSD Module, HP Z Turbo Drive 1TB SED TLC Z4/Z6 G4 SSD Kit & module to Storage section, Added Intel® Wi-Fi 6 AX200 & BT PCIe to Networking section |
| October 26, 2019 | From v18 to v19 | Changed | Graphics section |
| November 1, 2019 | From v19 to v20 | Added | NVDIMM Memory sections, Added HP QX310 Removable NVMe Frame/Carrier w/PCIe card to Optical and Removable Storage section |
| January 2, 2020 | From v20 to v21 | Changed | Storage section |
| February 26, 2020 | From v21 to v22 | Added | New Intel Xeon Processors |
| | | Changed | Overview, PCIe Solid State Drives sections |

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